

# CDX-602

## SERVICE MANUAL

US Model

Ver 1.0 2001.07



Model Name Using Similar Mechanism	CDX-646
CD Drive Mechanism Type	MG-251B-137
Optical Pick-up Name	KSS-720A

### SPECIFICATIONS

System	Compact disc digital audio system
Laser diode properties	Material: GaAlAs Wavelength: 780 nm Emission Duration: Continuous Laser out-put Power: Less than 44.6 $\mu$ W*
* This output is the value measured at a distance of 200 mm from the objective lens surface on the Optical Pick-up Block.	
Frequency response	10 – 20,000 Hz
Wow and flutter	Below the measurable limit
Signal-to-noise ratio	94 dB
Outputs	BUS control output (8 pins) Analog audio output (RCA pin)
Current drain	800 mA (during CD playback) 800 mA (during loading or ejecting a disc)
Operating temperature	-10°C to +55°C (14°F to 131°F)
Dimensions	Approx. 262 × 90 × 185 mm (10 <sup>3</sup> / <sub>8</sub> × 3 <sup>5</sup> / <sub>8</sub> × 7 <sup>3</sup> / <sub>8</sub> in.) (w/h/d) not incl. projecting parts and controls
Mass	Approx. 2.1 kg (4 lb. 10 oz.)
Power requirement	12 V DC car battery (negative ground)
Supplied accessories	Disc magazine (1) Parts for installation and connections (1 set)

*Design and specifications are subject to change without notice.*

## COMPACT DISC CHANGER

# SONY®

9-873-234-01  
2001G0500-1  
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**Sony Corporation**  
e Vehicle Company  
Shinagawa Tec Service Manual Production Group

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**Notes on chip component replacement**

- Never reuse a disconnected chip component.
- Notice that the minus side of a tantalum capacitor may be damaged by heat.

**Flexible Circuit Board Repairing**

- Keep the temperature of the soldering iron around 270 °C during repairing.
- Do not touch the soldering iron on the same conductor of the circuit board (within 3 times).
- Be careful not to apply force on the conductor when soldering or unsoldering.

**CAUTION**

Use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.

**SAFETY-RELATED COMPONENT WARNING!!**

**COMPONENTS IDENTIFIED BY MARK  $\triangle$  OR DOTTED LINE WITH MARK  $\triangle$  ON THE SCHEMATIC DIAGRAMS AND IN THE PARTS LIST ARE CRITICAL TO SAFE OPERATION. REPLACE THESE COMPONENTS WITH SONY PARTS WHOSE PART NUMBERS APPEAR AS SHOWN IN THIS MANUAL OR IN SUPPLEMENTS PUBLISHED BY SONY.**

SECTION 1
SERVICING NOTES

NOTES ON HANDLING THE OPTICAL PICK-UP BLOCK OR BASE UNIT

The laser diode in the optical pick-up block may suffer electrostatic breakdown because of the potential difference generated by the charged electrostatic load, etc. on clothing and the human body. During repair, pay attention to electrostatic breakdown and also use the procedure in the printed matter which is included in the repair parts.

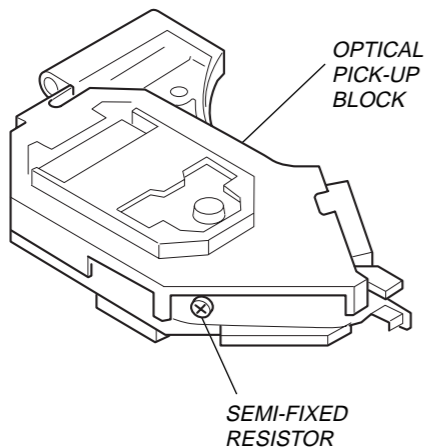
The flexible board is easily damaged and should be handled with care.

NOTES ON LASER DIODE EMISSION CHECK

The laser beam on this model is concentrated so as to be focused on the disc reflective surface by the objective lens in the optical pick-up block. Therefore, when checking the laser diode emission, observe from more than 30 cm away from the objective lens.

If the optical pick-up block is defective, please replace the whole optical pick-up block.

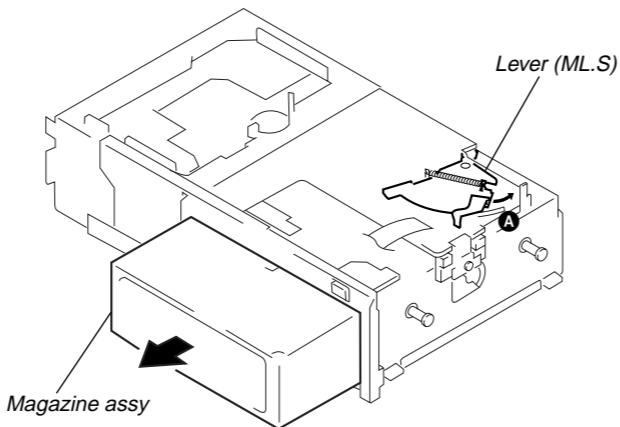
Never turn the semi-fixed resistor located at the side of optical pick-up block.



DISC MAGAZINE GETTING OUT PROCEDURE ON THE POWER SUPPLY IS OFF

Remove the CASE (LOWER.T) beforehand

- 1) Press the lever (ML.S) assy in the direction of arrow A.
2) Removal the magazine assy.
Note: Take out the magazine only when the tray is completely within the magazine. If the disk or tray is sticking out, turn on the power and eject the magazine.



SECTION 2
GENERAL

This section is extracted from instruction manual.

Inserting a disc / Insertion d'un disque / Inserción de discos. Includes diagrams for disc insertion, tray operation, and disc ejection in multiple languages.

- Notes on the disc magazine / Remarques sur le chargeur de disques / Notas sobre el cargador de discos. Safety and handling instructions for the disc magazine.

When the tray comes out / Si la bandeja se sale. Instructions for handling the tray when it is ejected.

- Notes on handling discs / Remarques sur la manipulation des disques / Notas sobre el manejo de discos. Guidelines for safe disc handling.

Notes on CD-R discs / Remarques sur les disques CD-R / Notas sobre discos CD-R. Specific instructions for CD-R recording and playback.

Notes on CD-R discs (continued) / Remarques sur les disques CD-R (continued) / Notas sobre discos CD-R (continued).

Notes on CD-R discs (continued) / Remarques sur les disques CD-R (continued) / Notas sobre discos CD-R (continued).

Notes on CD-R discs (continued) / Remarques sur les disques CD-R (continued) / Notas sobre discos CD-R (continued).

Look for this mark to distinguish CD-Rs for audio use. Ce symbole permet de distinguer les CD-R conçus pour une utilisation audio. Busque esta marca para distinguir los discos CD-R para uso de audio. Este símbolo indica que el disco no es para uso de audio. 此符號表示該唱碟為非音頻唱碟。

# Installation

## Precautions

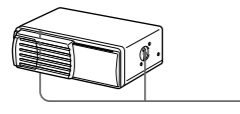
- Choose the mounting location carefully, observing the following:
  - The unit is not subject to temperatures exceeding 55°C (131°F) (such as in a car parked in direct sunlight).
  - The unit is not subject to direct sunlight.
  - The unit is not near heat sources (such as heaters).
  - The unit is not exposed to rain or moisture.
  - The unit is not exposed to excessive dust or dirt.
  - The unit is not subject to excessive vibration.
  - The fuel tank should not be damaged by the tapping screws.
  - There should be no wire harnesses or pipes under the place where you are going to install the unit.
  - The spare tire, tools or other equipment in or under the trunk should not be interfered with or damaged by the screws or the unit itself.
- Be sure to use only the supplied mounting hardware for a safe and secure installation.
- Use only the supplied screws.
- Make holes of  $\phi 3.5$  mm ( $\frac{7}{32}$  in.) only after making sure there is nothing on the other side of the mounting surface.

## How to install the unit

The brackets ① provide two positions for mounting, high and low. Use the appropriate screw holes according to your preference.

### Horizontal installation

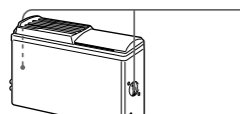
**1**



Align with the marked position.  
Aligner sur le repère.  
Alinee en la posición marcada.  
對準標誌位置。

### Vertical installation

**1**



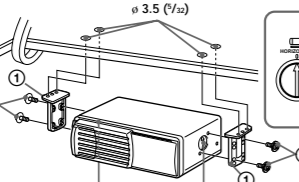
Align with the marked position.  
Aligner sur le repère.  
Alinee en la posición marcada.  
對準標誌位置。

### Suspended installation

When the unit is to be installed under the rear tray etc. in the trunk compartment, make sure the following provisions are made.

- Choose the mounting location carefully so that the unit can be installed horizontally.
- Make sure the unit does not hinder the movement of the torsion bar spring etc. of the trunk lid.

**1**

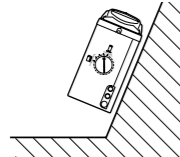


Unit: mm (in.)  
Unité: mm (po.)  
Unidad: mm  
單位: mm

Align with the marked position.  
Aligner sur le repère.  
Alinee en la posición marcada.  
對準標誌位置。

### Inclined installation

After installing the unit, align the dials with one of the marks so that the arrows are as vertical as possible.



**Note**  
Be sure to align the left and right dials with the same mark.

# Installation

## Précautions

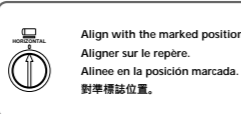
- Choisir l'emplacement de montage en tenant compte des observations suivantes:
  - Appareil non soumis à des températures dépassant 55°C (131°F) (comme dans une voiture parkée au soleil).
  - Appareil non soumis au rayonnement solaire direct.
  - Appareil à l'écart de sources de chaleur (comme des radiateurs).
  - Appareil non exposé à la pluie ou à l'humidité.
  - Appareil non exposé à des poussières ou à des souillures en excès.
  - Appareil non exposé à des vibrations excessives.
  - Vérifier que le réservoir d'essence ne risque pas d'être endommagé par les vis taraudeuses.
  - Il ne doit pas y avoir de faisceau de fils ou de tuyaux à l'emplacement du montage.
  - Ne pas laisser l'appareil ou les vis risquent pas d'endommager ou de gêner la roue de secours, les outils, ou autre objet dans le coffre.
- Pour garantir la sécurité de l'installation, utiliser uniquement le matériel de montage fourni.
- Utilisez uniquement les vis fournies.
- Ne percez les trous de 3,5 mm ( $\frac{7}{32}$  po.) qu'après vous être assuré qu'il n'y avait rien de l'autre côté de la surface de montage.

## Installation de l'appareil

Les supports ① offrent deux positions de montage, haut et bas. Utilisez les trous de vissage appropriés en fonction de vos préférences.

### Installation horizontale

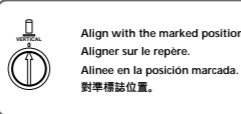
**1**



Align with the marked position.  
Aligner sur le repère.  
Alinee en la posición marcada.  
對準標誌位置。

### Installation verticale

**1**



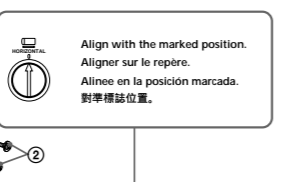
Align with the marked position.  
Aligner sur le repère.  
Alinee en la posición marcada.  
對準標誌位置。

### Installation suspendue

Si l'appareil doit être installé sous la plage arrière dans le coffre, par exemple, observer les précautions suivantes.

- Bien choisir l'emplacement pour pouvoir installer l'appareil à l'horizontale.
- Vérifier que l'appareil ne gêne pas les mouvements du ressort de fermeture du coffre, entre autres.

**1**




Unit: mm (in.)  
Unité: mm (po.)  
Unidad: mm  
單位: mm

Align with the marked position.  
Aligner sur le repère.  
Alinee en la posición marcada.  
對準標誌位置。

### Installation inclinée

Après avoir installé l'appareil, alignez les disques sur un repère de façon à ce que les flèches soient dans la position la plus verticale possible.



**Remarque**  
Veillez à aligner les disques gauche et droite sur le même repère.

# Instalación

## Precauciones

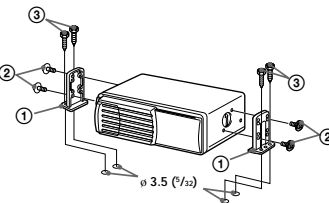
- Elija cuidadosamente el lugar de montaje y tenga en cuenta lo siguiente:
  - La unidad no queda sometida a temperaturas superiores a los 55°C (como en un automóvil aparcado a la luz solar directa).
  - La unidad no queda sometida a la luz solar directa.
  - La unidad no queda cercana a fuentes térmicas (como aparatos de calefacción).
  - La unidad no queda expuesta a la lluvia o a la humedad.
  - La unidad no queda expuesta a polvo o suciedad excesivos.
  - La unidad no queda sometida a vibraciones excesivas.
  - El depósito de combustible no deberá dañarse con los tornillos autorroscantes.
  - No deberá haber mazos de conductores ni tubos debajo del lugar donde vaya a instalar la unidad.
  - La rueda de repuesto, las herramientas, u otros equipos situados dentro o debajo del portaequipajes no deberán verse interferidos ni dañados por los tornillos ni por la propia unidad.
- Para realizar una instalación segura, emplee solamente la ferretería de montaje suministrada.
- Utilice sólo los tornillos suministrados.
- Antes de hacer los orificios de  $\phi 3,5$  mm, compruebe que no haya nada en el otro lado de la superficie de montaje.

## Instalación de la unidad

Los soportes ① proporcionan dos posiciones de montaje, alta y baja. Utilice los orificios para tornillo apropiados según sus preferencias.

### Instalación horizontal

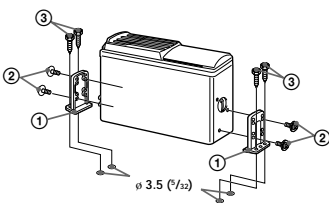
**2**



Unit: mm (in.)  
Unité: mm (po.)  
Unidad: mm  
單位: mm

### Instalación vertical

**2**



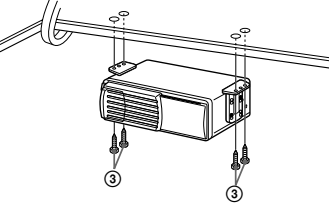
Unit: mm (in.)  
Unité: mm (po.)  
Unidad: mm  
單位: mm

### Instalación suspendida

Si va a instalar la unidad debajo de la bandeja trasera, etc., del maletero, tenga en cuenta lo siguiente:

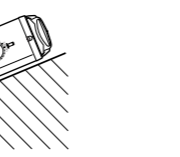
- Elija el lugar de montaje cuidadosamente de forma que sea posible instalar la unidad horizontalmente.
- Asegúrese de que la unidad no dificulte el movimiento del muelle de la barra de torsión, etc., de la tapa del maletero.

**2**



### Instalación inclinada

Una vez instalada la unidad, alinee los diales de forma que una de las marcas de las flechas se encuentre en la posición más vertical posible.



**Nota**  
Asegúrese de alinear los diales izquierdo y derecho con la misma marca.

# 安裝

## 使用前須注意

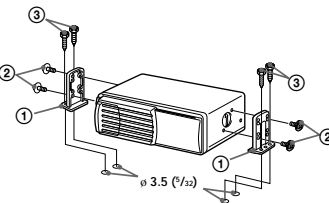
- 請參照下列各項仔細選擇安裝位置：
  - 機器不能遭受超過 55 的溫度（例如停駐於炎陽下的汽車內）。
  - 機器不可直接照射到陽光。
  - 機器不可靠近熱源（例如加熱器等）。
  - 不要讓機器暴露雨中或潮濕處。
  - 不要把機器放在多塵或污穢的地方。
  - 別讓機器受到強烈的震動。
  - 小心別讓攻絲螺釘鑽傷了燃油箱。
  - 注意安裝機器位置下面不要有電線束或配管。
  - 行李箱中或下面的備胎，工具或其他設備的取存不可受到機器的安裝螺釘或機器本身的干擾或損傷。
- 為了安裝確實和安全，請限使用附帶的安裝五金件。
- 限使用附帶的螺絲釘。
- 務請在確認安裝面的另一側沒有任何其他物品之後開  $\phi 3.5$  mm 的孔。

## 如何安裝機器

支架①提供了兩種安裝位置，高和低。跟据您的考慮，請使用合適的螺孔。

### 水平安裝

**2**



### 豎直安裝

**2**

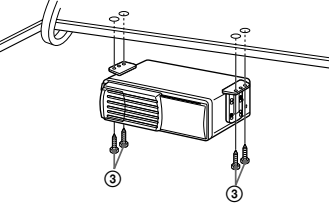


### 懸掛安裝

機器安裝在後行李箱托架下面等位置時，必須作好如下的準備。

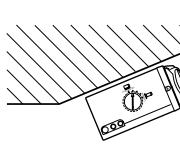
- 小心地選擇能水平地安裝機器的位置。
- 確認機器是否不會阻撓後行李箱蓋的扭桿彈簧等。

**2**



### 傾斜安裝

安裝好機器之後，請旋轉度盤對準標誌中的一個使箭頭盡可能呈垂直方向的位置。

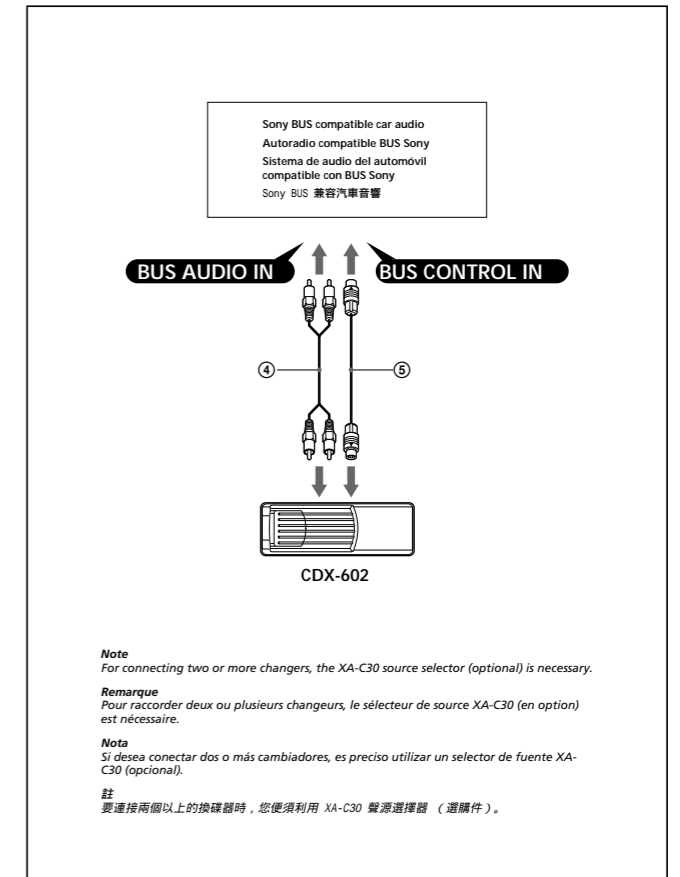


**註**  
左、右度盤一定要對準同一標誌。

# Connections/Connexions/Conexiones/連接

For details, refer to the Installation/Connections manual of the car audio.  
Pour plus de détails, consulter le manuel d'installation/connexions de l'autoradio.  
Con respecto a los detalles, consulte el manual de instalación/conexiones del sistema de audio del automóvil.  
詳細請參考汽車音響的安裝 / 連接說明。

## Connection diagram/Schéma de connexion/Diagrama de conexión/接線圖



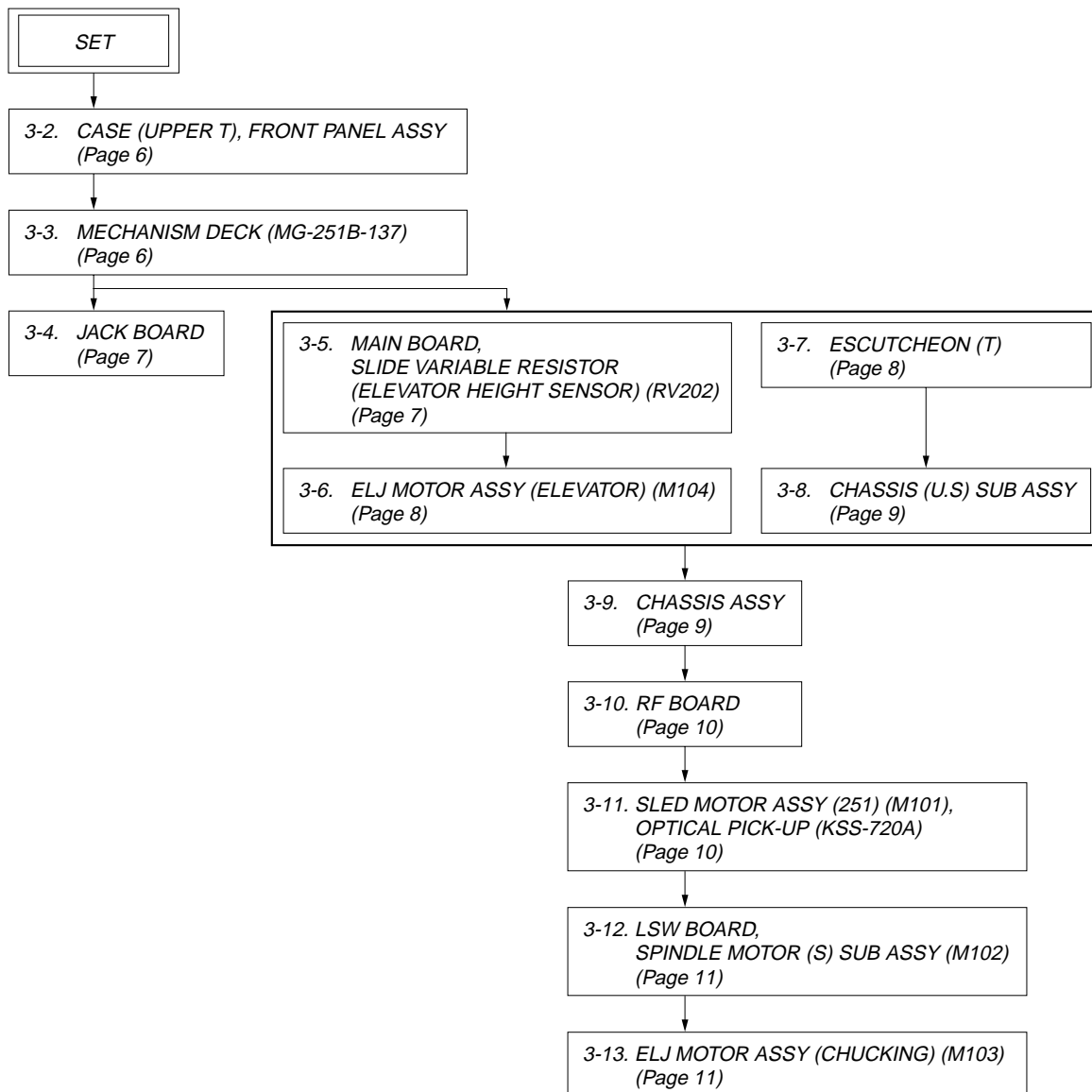
## SECTION 3 DISASSEMBLY

• This set can be disassembled in the order shown below.

### 3-1. DISASSEMBLY FLOW

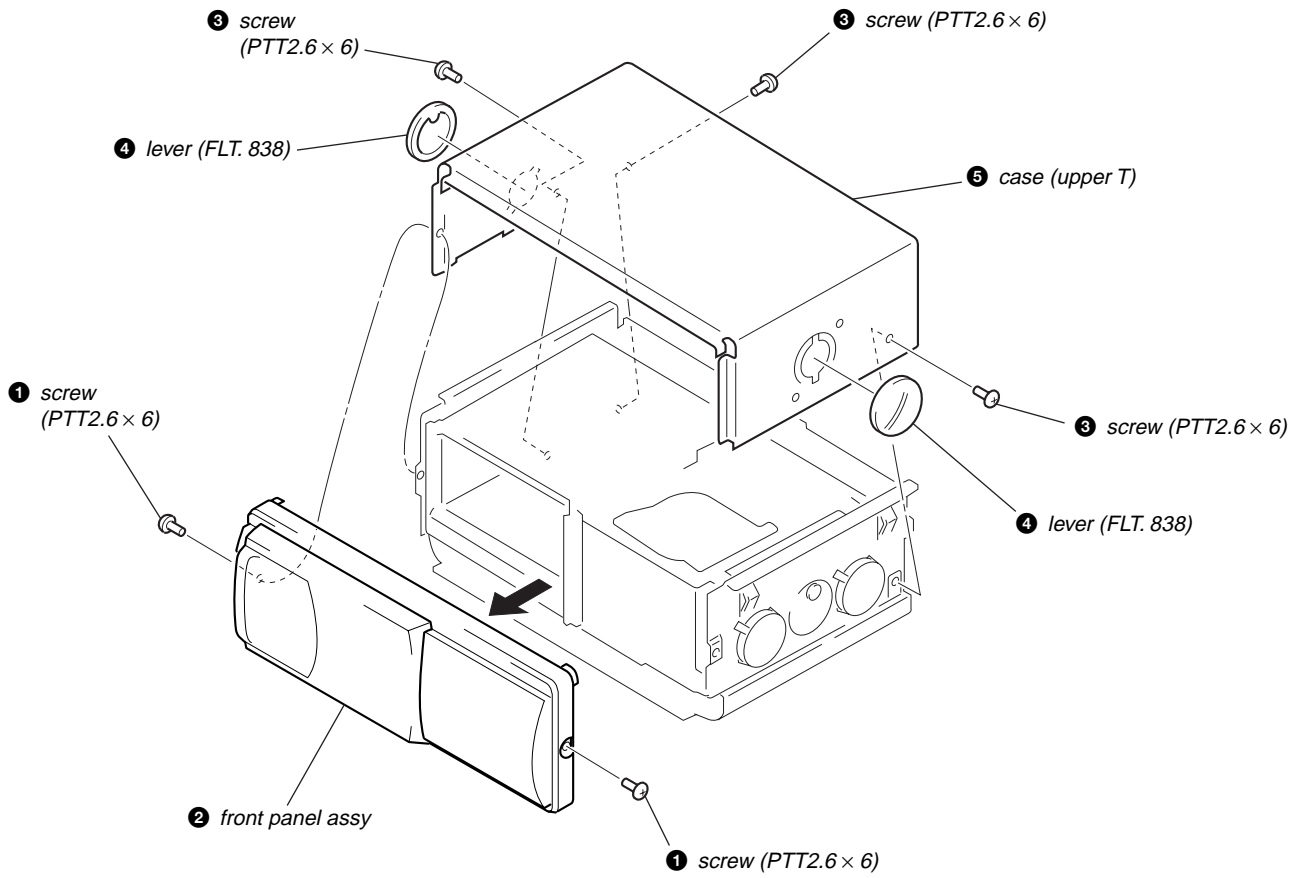
**Note 1:** The process described in [ ] can be performed in any order.

**Note 2:** Without completing the process described in [ ], the next process can not be performed.

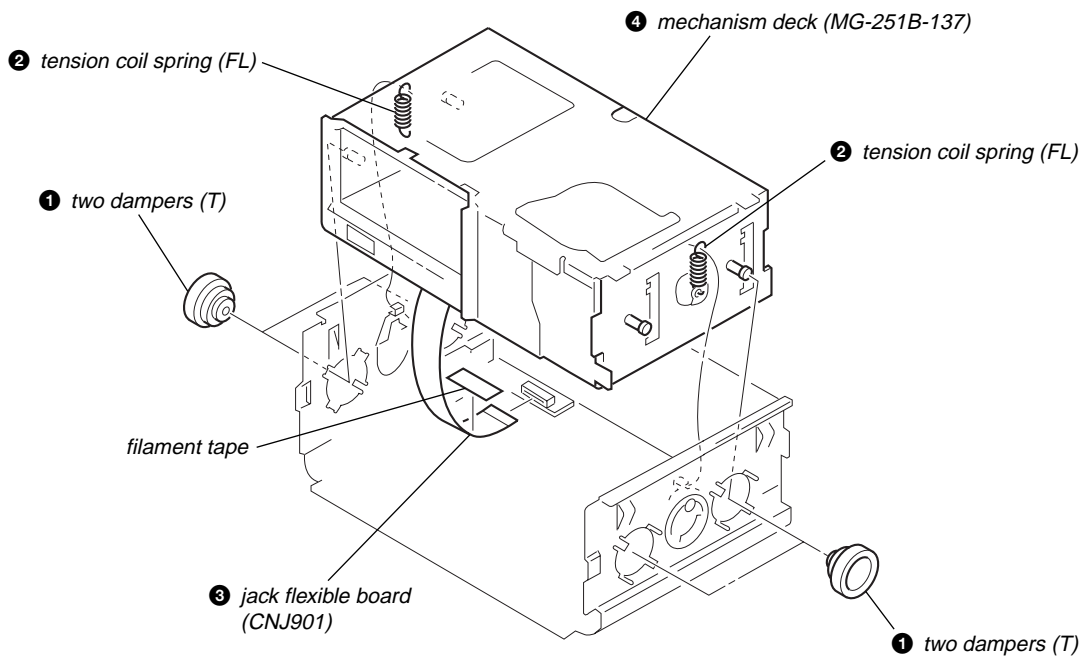


**Note:** Follow the disassembly procedure in the numerical order given.

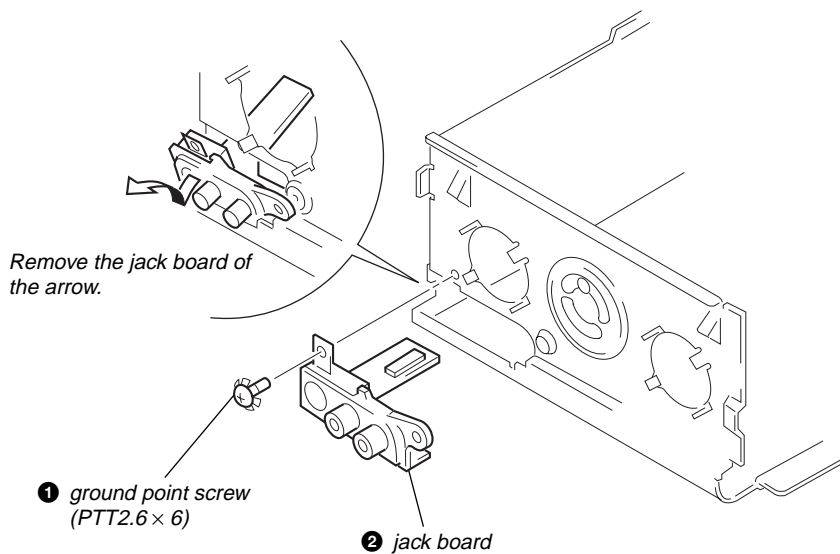
**3-2. CASE (UPPER T), FRONT PANEL ASSY**



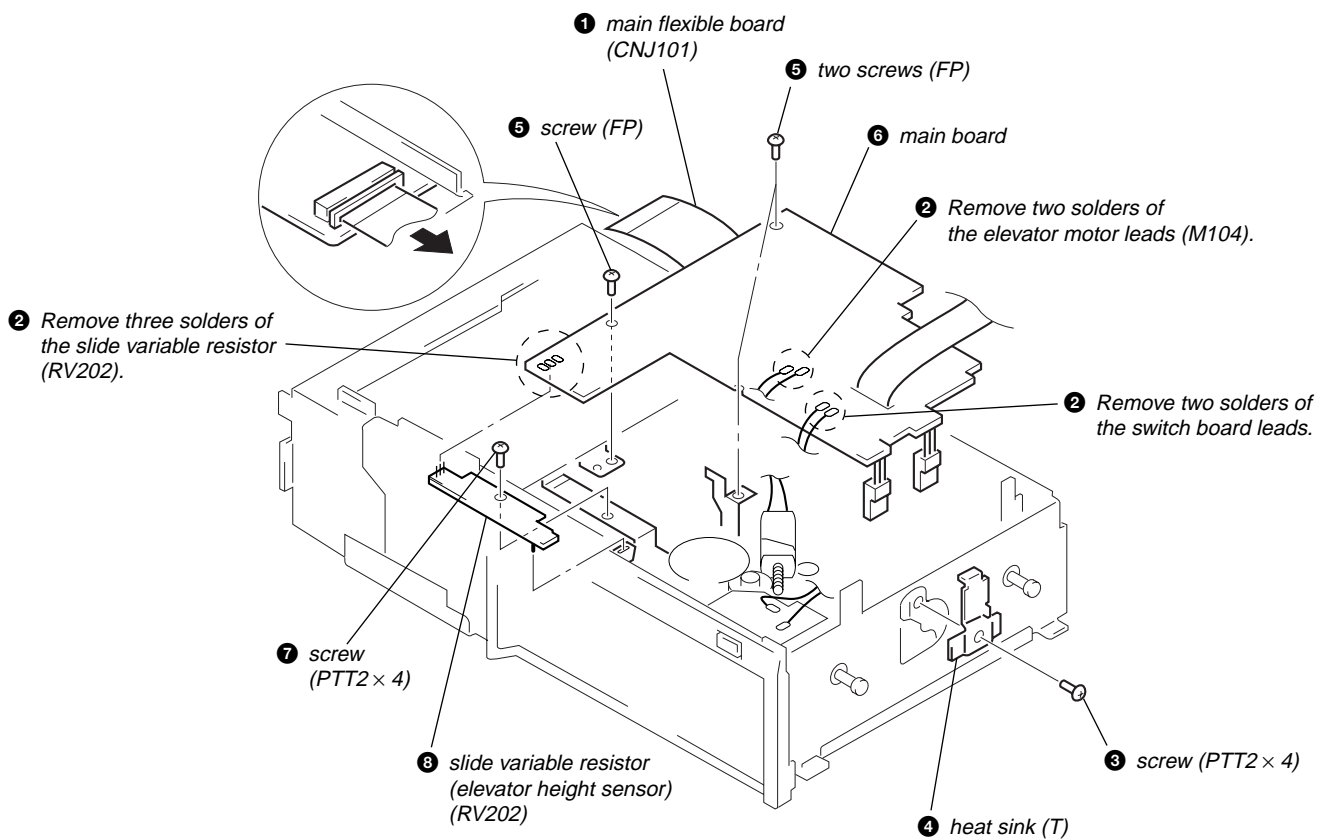
**3-3. MECHANISM DECK (MG-251B-137)**



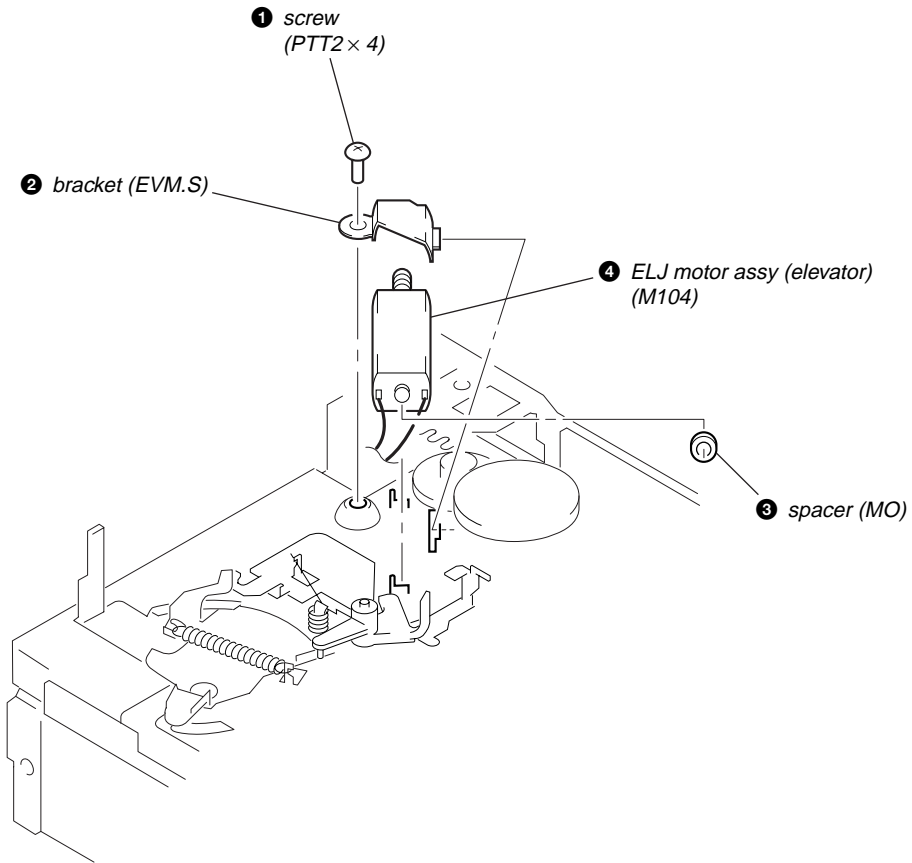
3-4. JACK BOARD



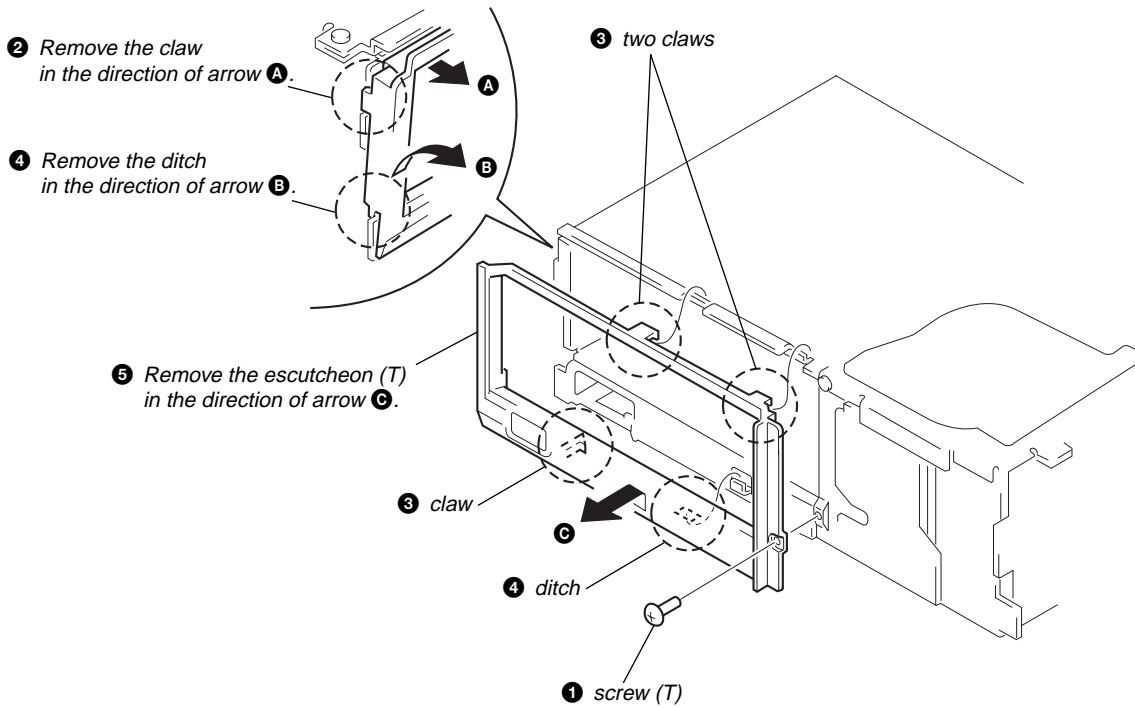
3-5. MAIN BOARD, SLIDE VARIABLE RESISTOR (ELEVATOR HEIGHT SENSOR) (RV202)



3-6. ELJ MOTOR ASSY (ELEVATOR) (M104)

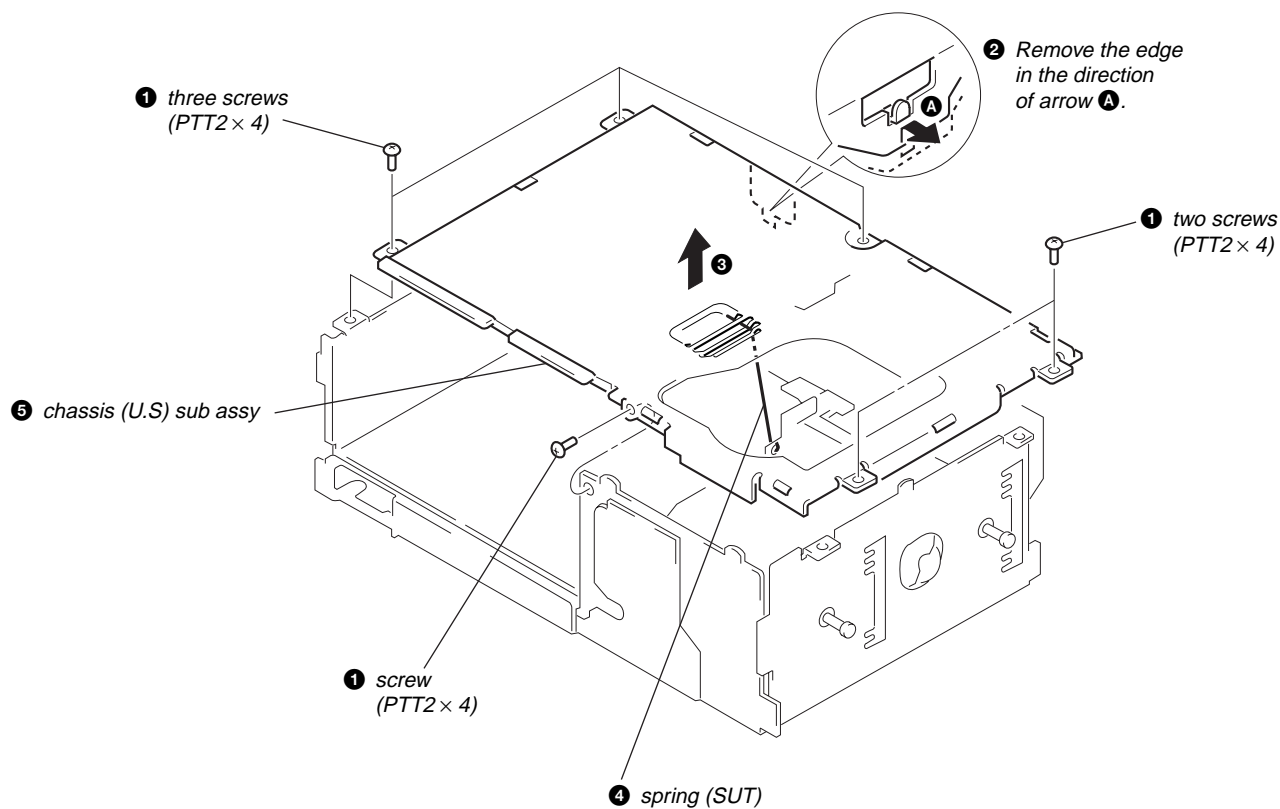


3-7. ESCUTCHEON (T)

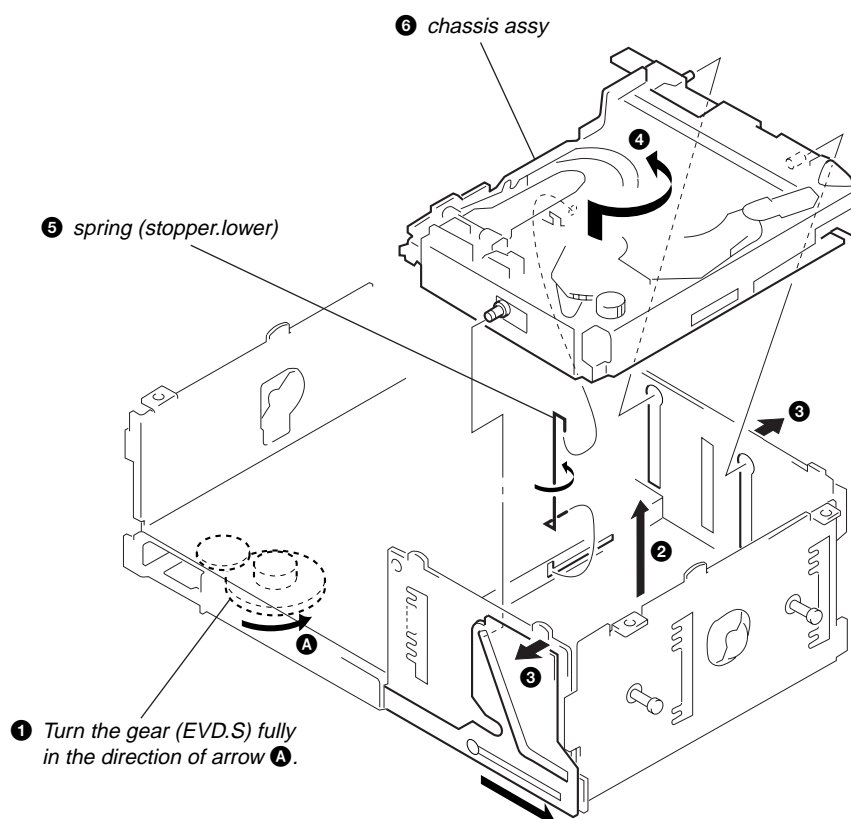




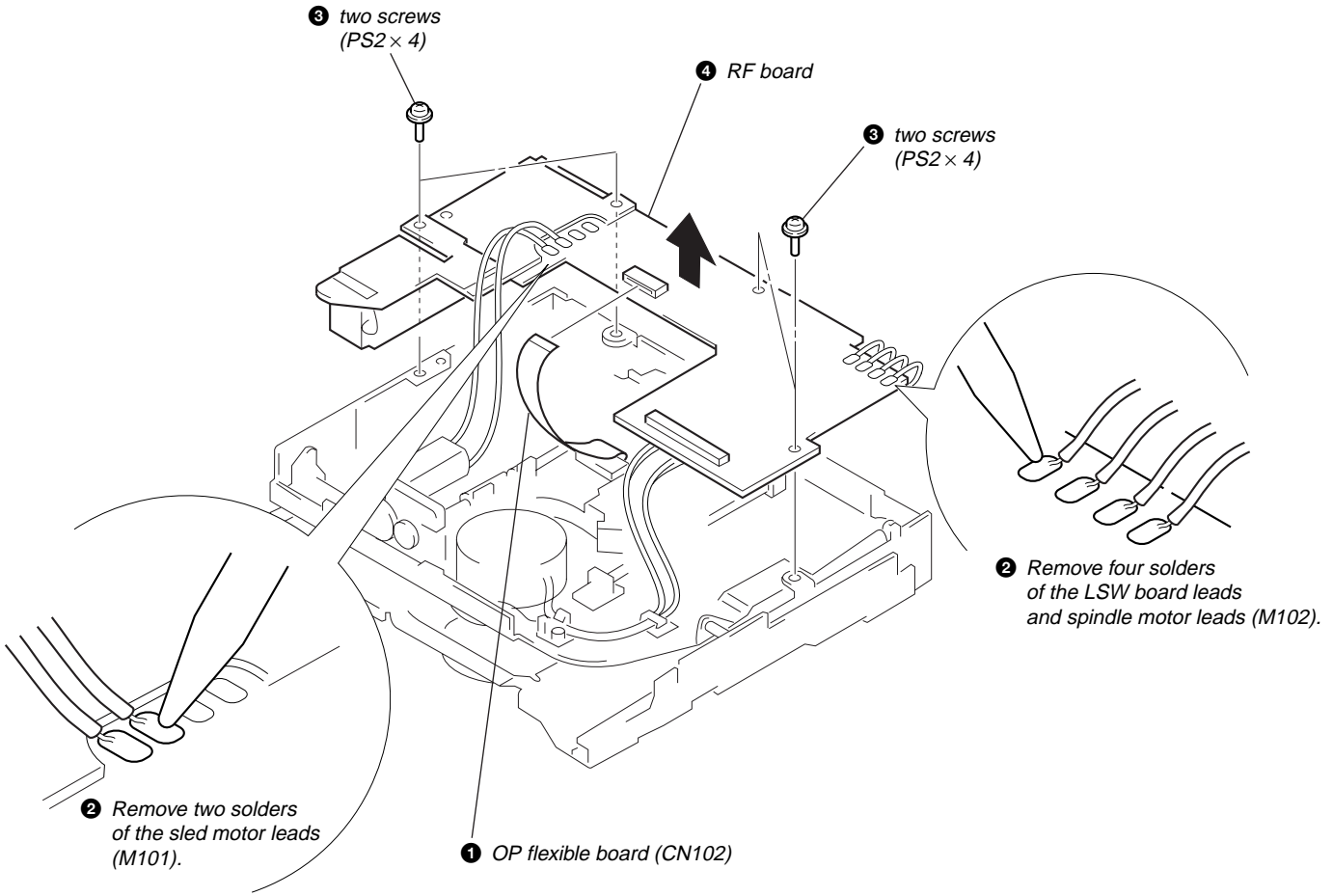
3-8. CHASSIS (U.S) SUB ASSY



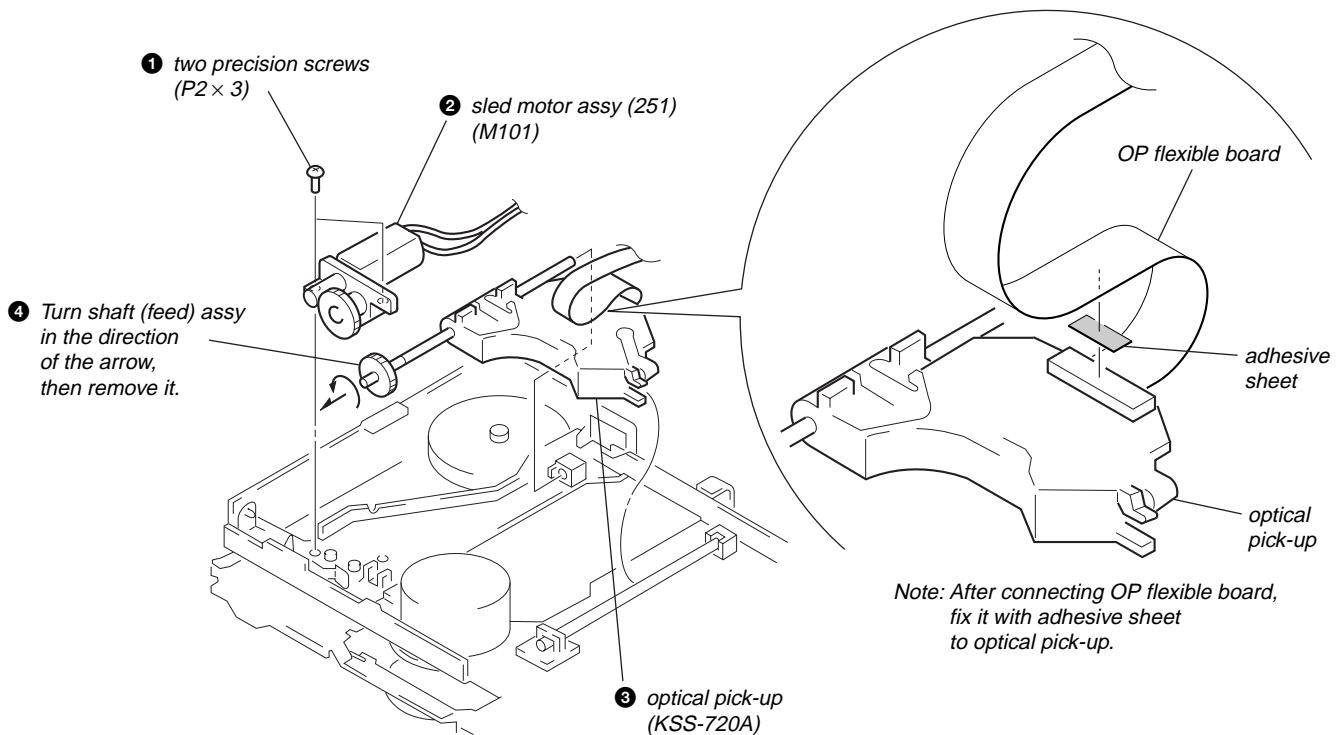
3-9. CHASSIS ASSY



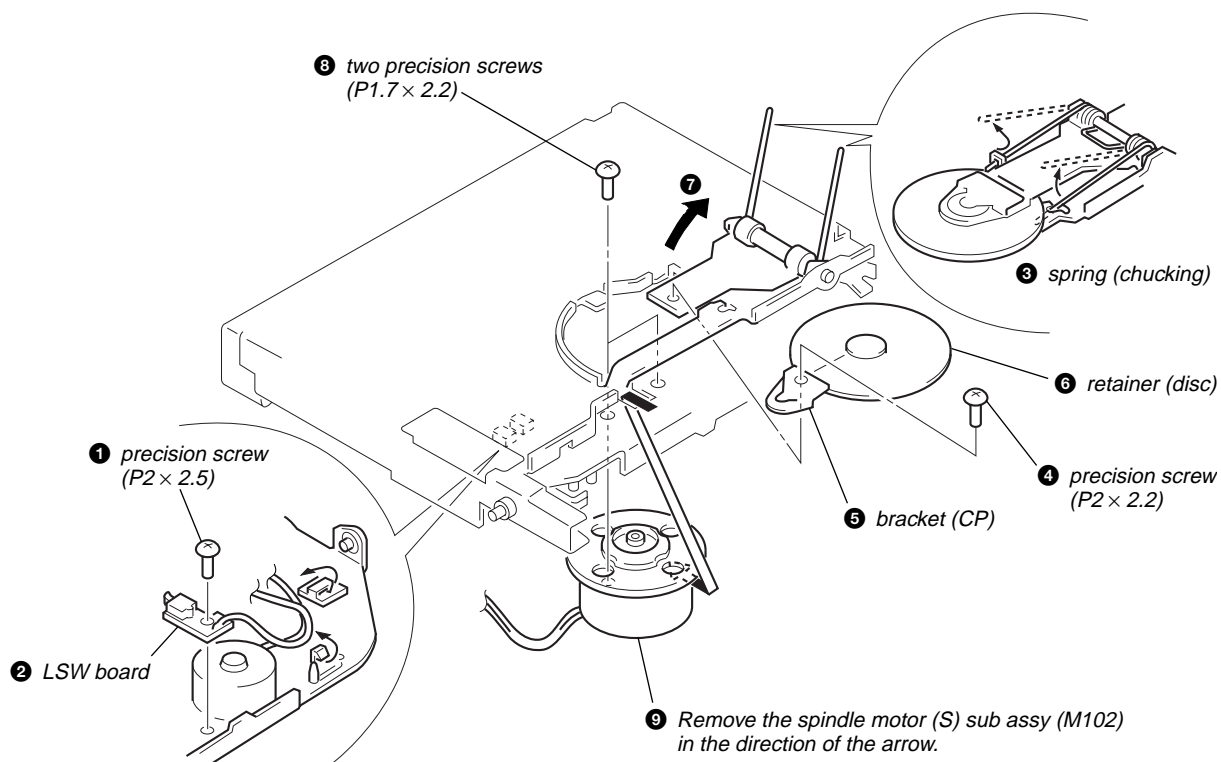
3-10. RF BOARD



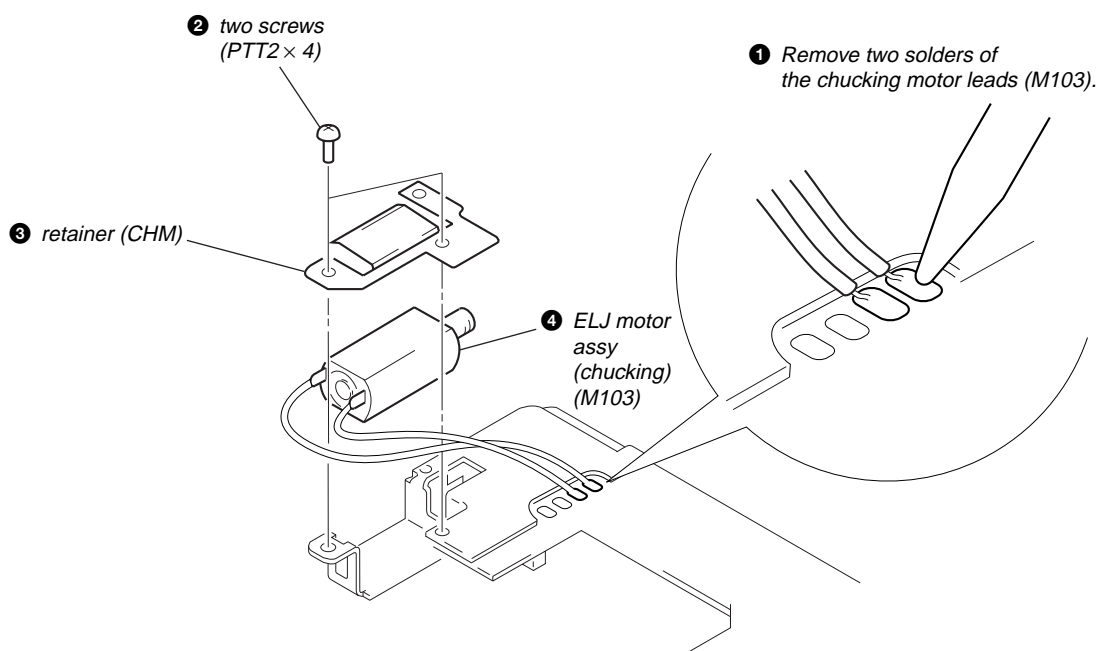
3-11. SLED MOTOR ASSY (251) (M101), OPTICAL PICK-UP (KSS-720A)



3-12. LSW BOARD, SPINDLE MOTOR (S) SUB ASSY (M102)



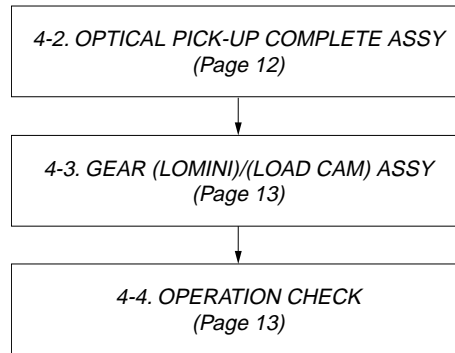
3-13. ELJ MOTOR ASSY (CHUCKING) (M103)



## SECTION 4 ASSEMBLY

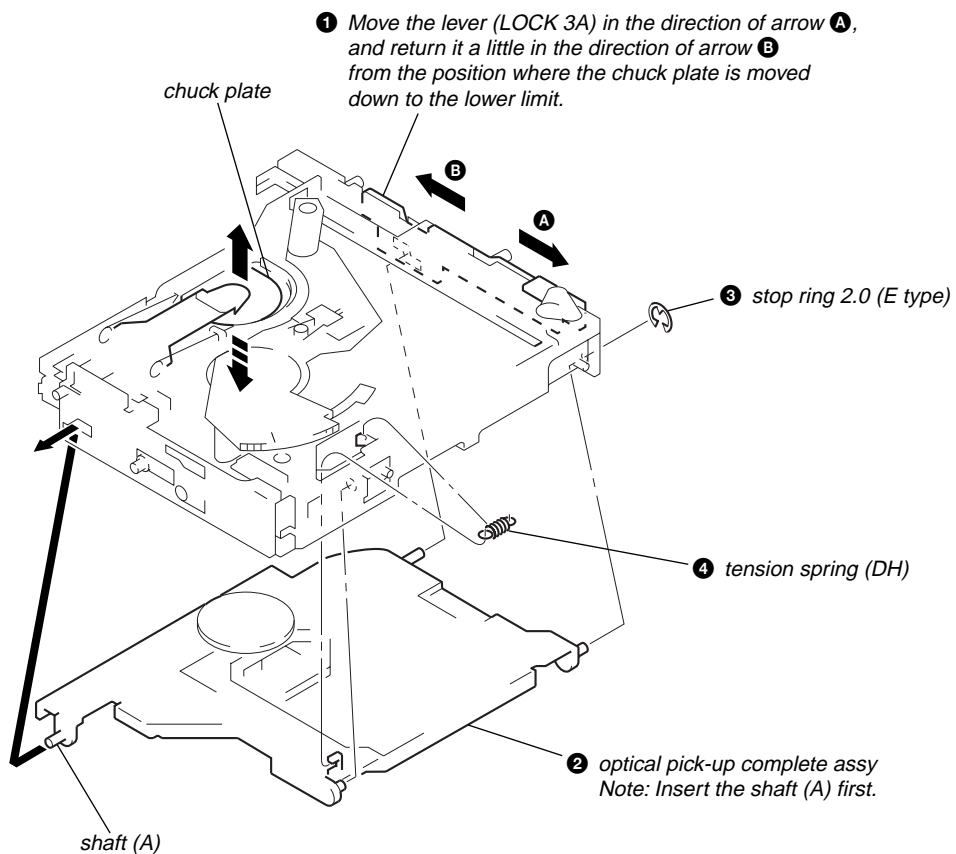
• This set can be assembled in the order shown below.

### 4-1. ASSEMBLY FLOW

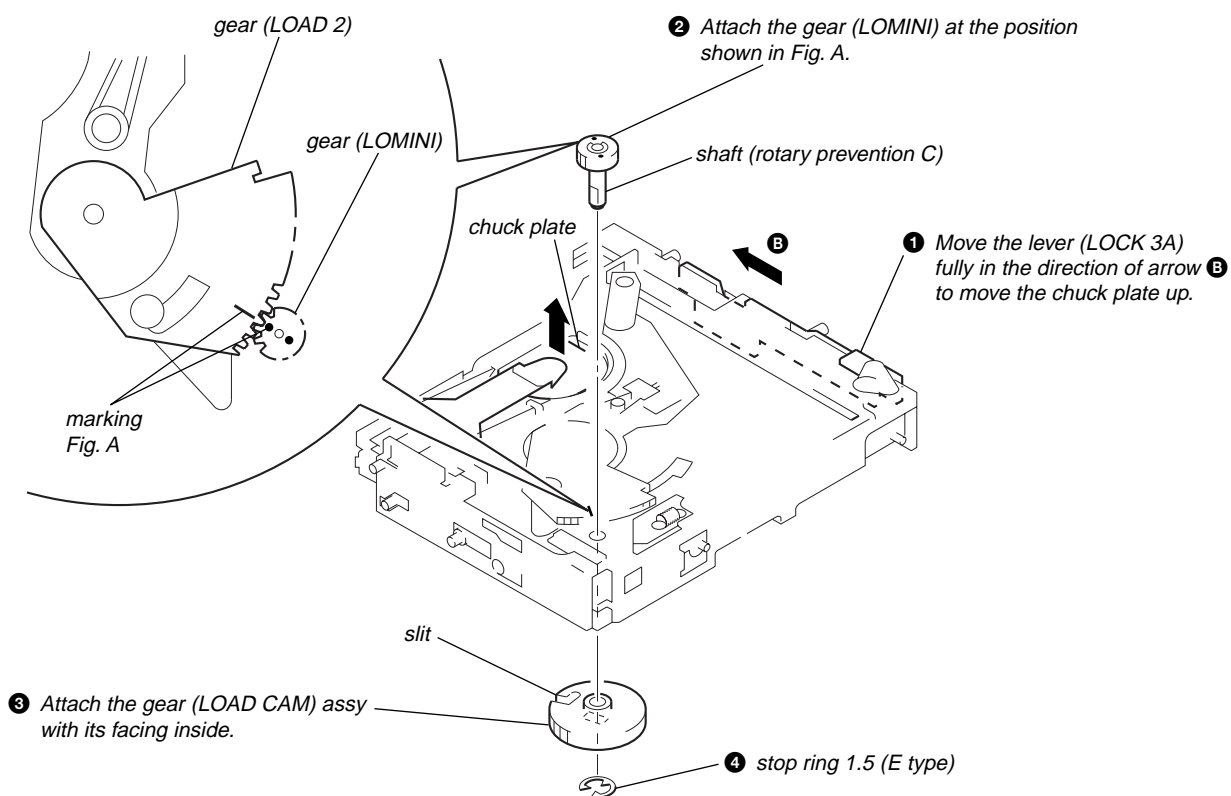


**Note:** Follow the assembly procedure in the numerical order given.

### 4-2. OPTICAL PICK-UP COMPLETE ASSY

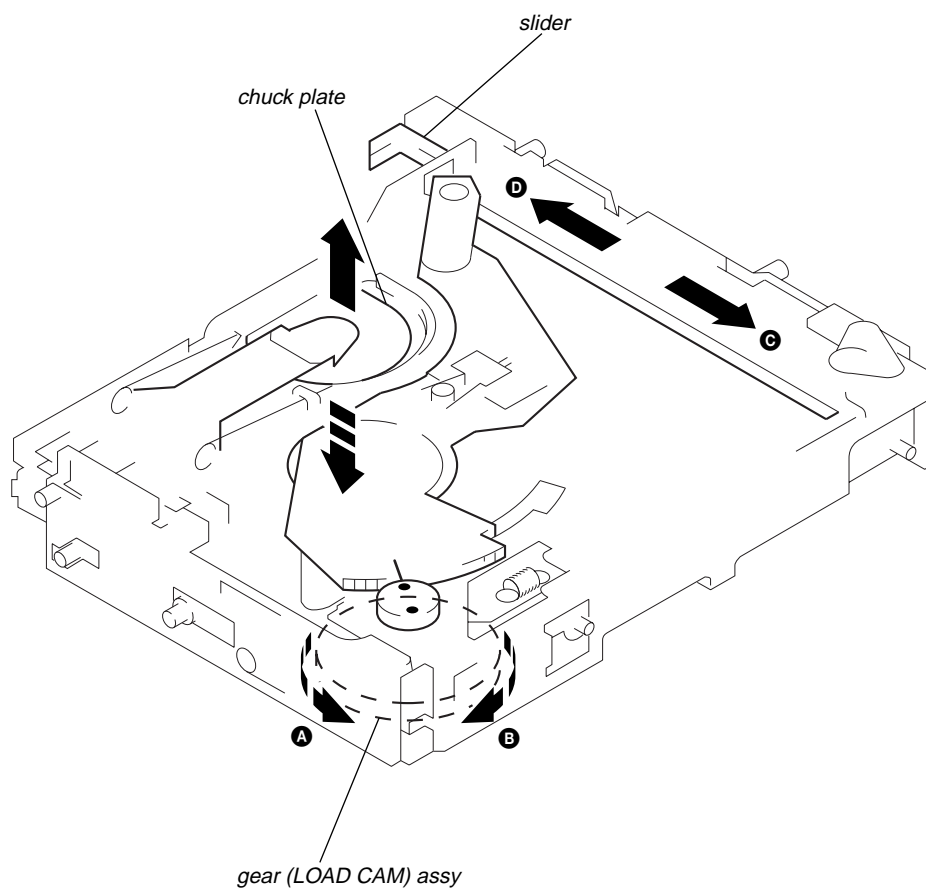


**4-3. GEAR (LOMINI)/(LOAD CAM) ASSY**



**4-4. OPERATION CHECK**

- 1** Confirm that the slider moves in the direction of arrow **C** to move down the chuck plate if the gear (LOAD CAM) is rotated in the direction of arrow **A** or the chuck plate moves up and the slider moves in the direction of arrow **D** if the gear is rotated in the direction of arrow **B**.

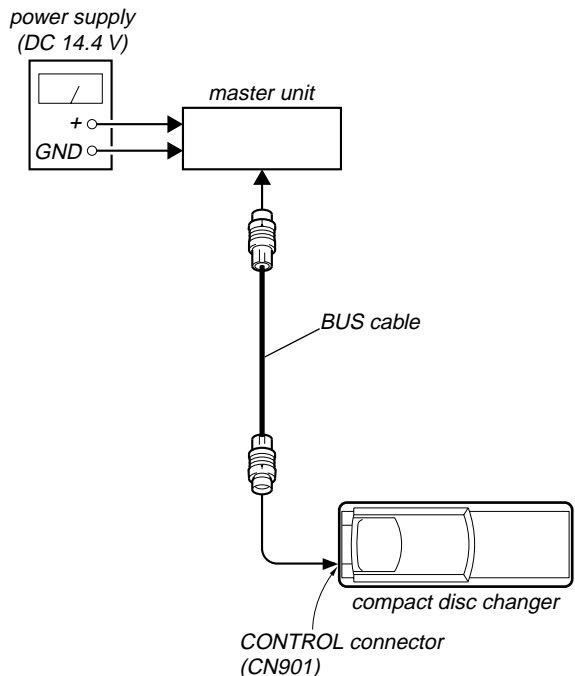


## SECTION 5 MECHANICAL ADJUSTMENT

### • Elevator Height (Address) Adjustment

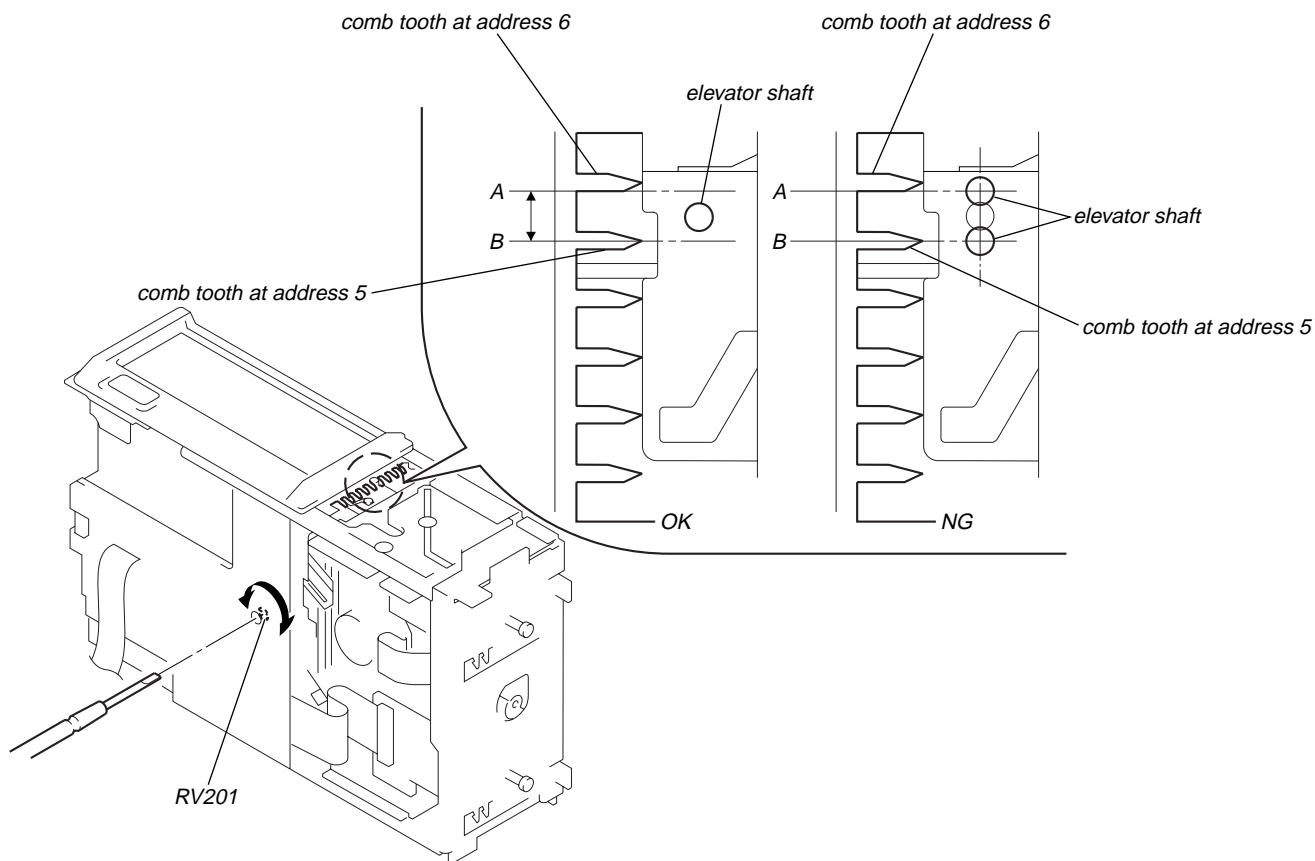
**Note:** This adjustments is necessary when the system controller (IC201), variable resistor (RV201), slider (R), slider (L), or chassis (ELV) was replaced for any repair.

**Connection:**



**Adjustment Method:**

1. Connect this set to the master unit (e.g. MDX-C7970/C7970R), load a disc magazine, and place the set vertically as shown below.
2. Connect the regulated power supply to the master unit, and turn the power on.
3. Press the DISC button on the master unit and select DISC 5.
4. At this time, if the elevator shaft does not position between comb teeth A and B at addresses 5 and 6 as shown below, adjust the following.
5. Press repeatedly the DISC + and – buttons on the master unit so that the elevator shafts moves from address 6 to address 5, or from 5 to 6. At this time, adjust RV201 on the main board so that the elevator shaft positions smoothly between comb teeth A and B.
6. Further, place the set horizontally and make same adjustment as mentioned above.
7. After adjustment at addresses 5 to 6 is finished, check all operations from addresses 1 to 10 with the set placed vertically and horizontally respectively to confirm that the elevator shaft positions in a range between comb teeth A to B.

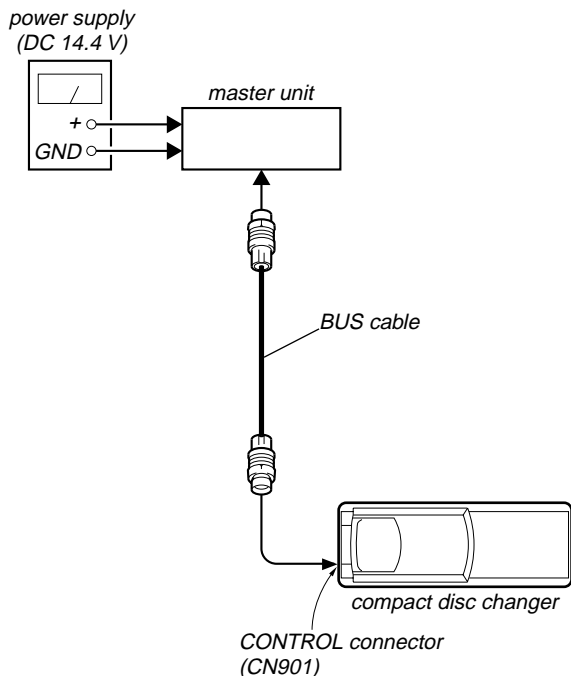


## SECTION 6 ELECTRICAL CHECK

**Note:**

1. This check is performed with the set placed horizontally.
2. Power supply voltage: DC14.4 V (more than 3 A).
3. Be sure to use the disc "YEDS-18" parts code: 3-702-101-01, but only when indicated.

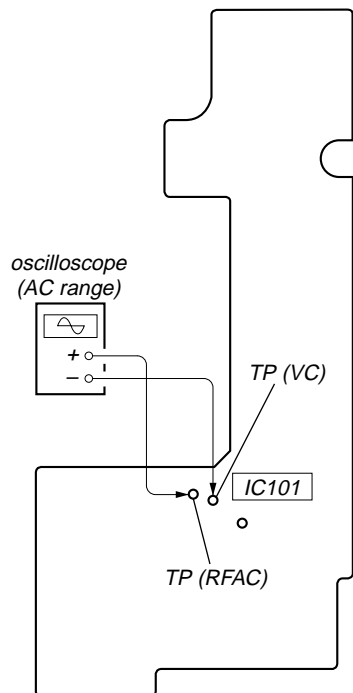
**Connection:**



**Focus Bias Check**

**Connection:**

– RF Board (Component Side) –



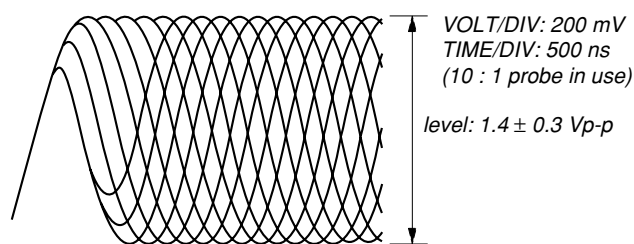
**Procedure:**

1. Connect the oscilloscope to TP (RFAC) and TP (VC) on the RF board.
2. Put the set into play mode by loading the disc (YEDS-18).
3. Confirm that oscilloscope waveform is clear and check RF signal level is correct or not.

**Note:**

Clear RF signal waveform means that the shape "◇" can be clearly distinguished at the center of the waveform.

*RF signal waveform*

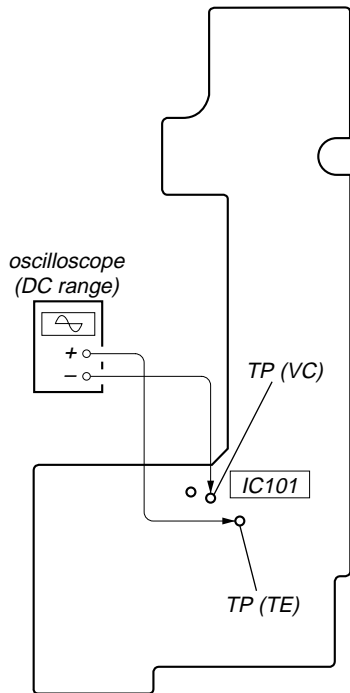


When observing the eye pattern, set the oscilloscope to AC range and raise the vertical sensitivity so that it may be easily seen.

## Tracking Offset Check

### Connection:

– RF Board (Component Side) –

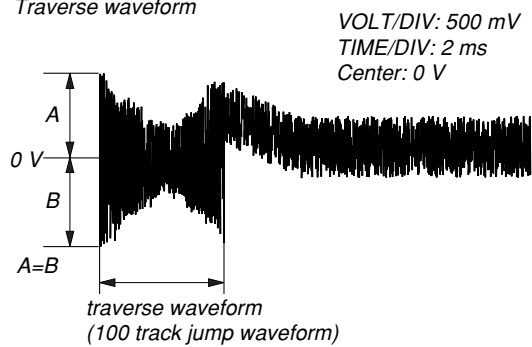


### Procedure:

1. Connect the oscilloscope to TP (TE) and TP (VC) on the RF board.
2. Put the set into play mode by loading the disc (YEDS-18).
3. Press the **◀◀ AMS ▶▶** button on the master unit, and check the traverse waveform\*.
4. Confirm that the oscilloscope waveform is symmetrical on the top and bottom in relation to 0 V dc, and check this level.

\* Traverse waveform: This is the tracking error wave form appears when crossing the track.

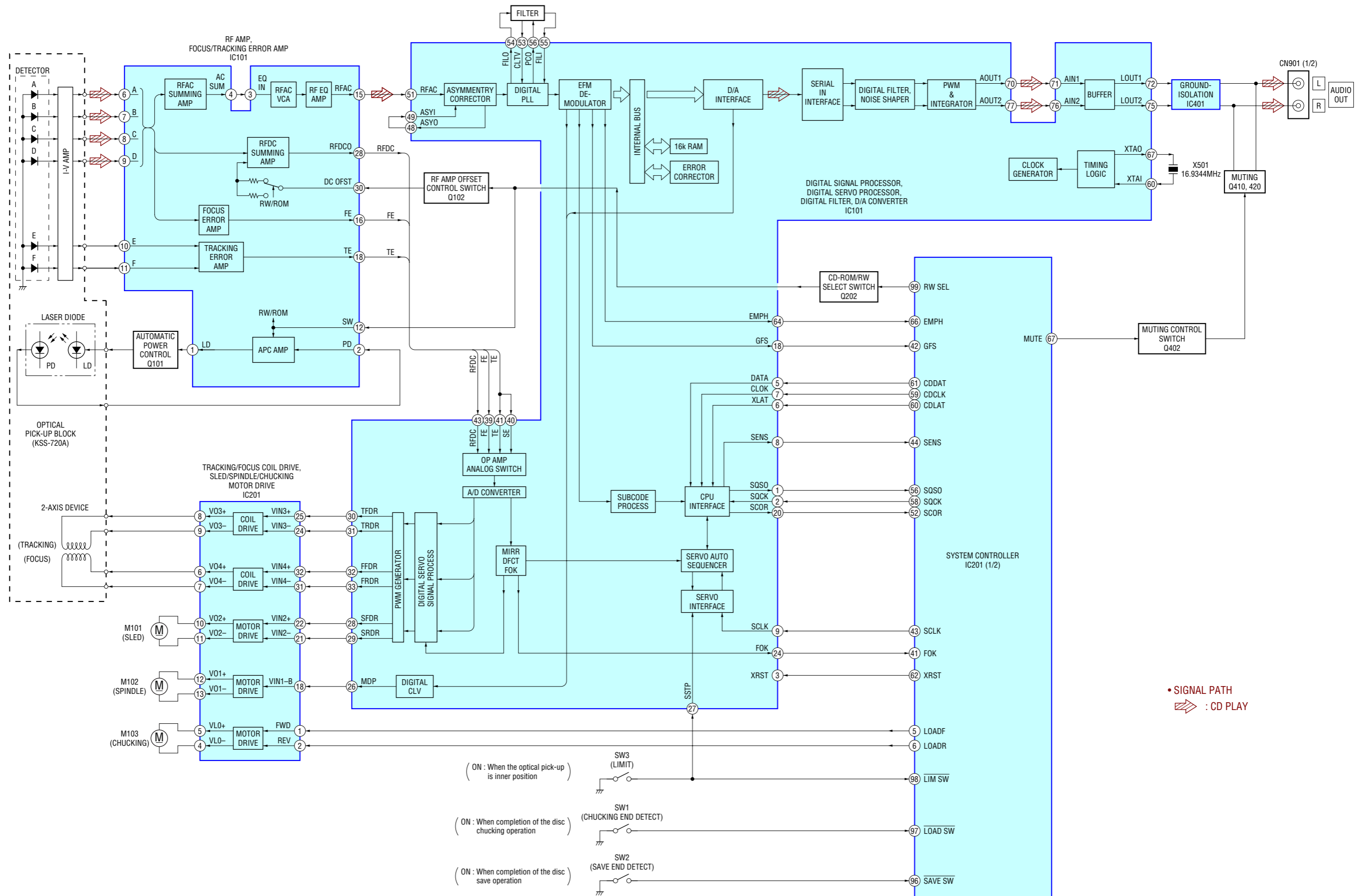
Traverse waveform



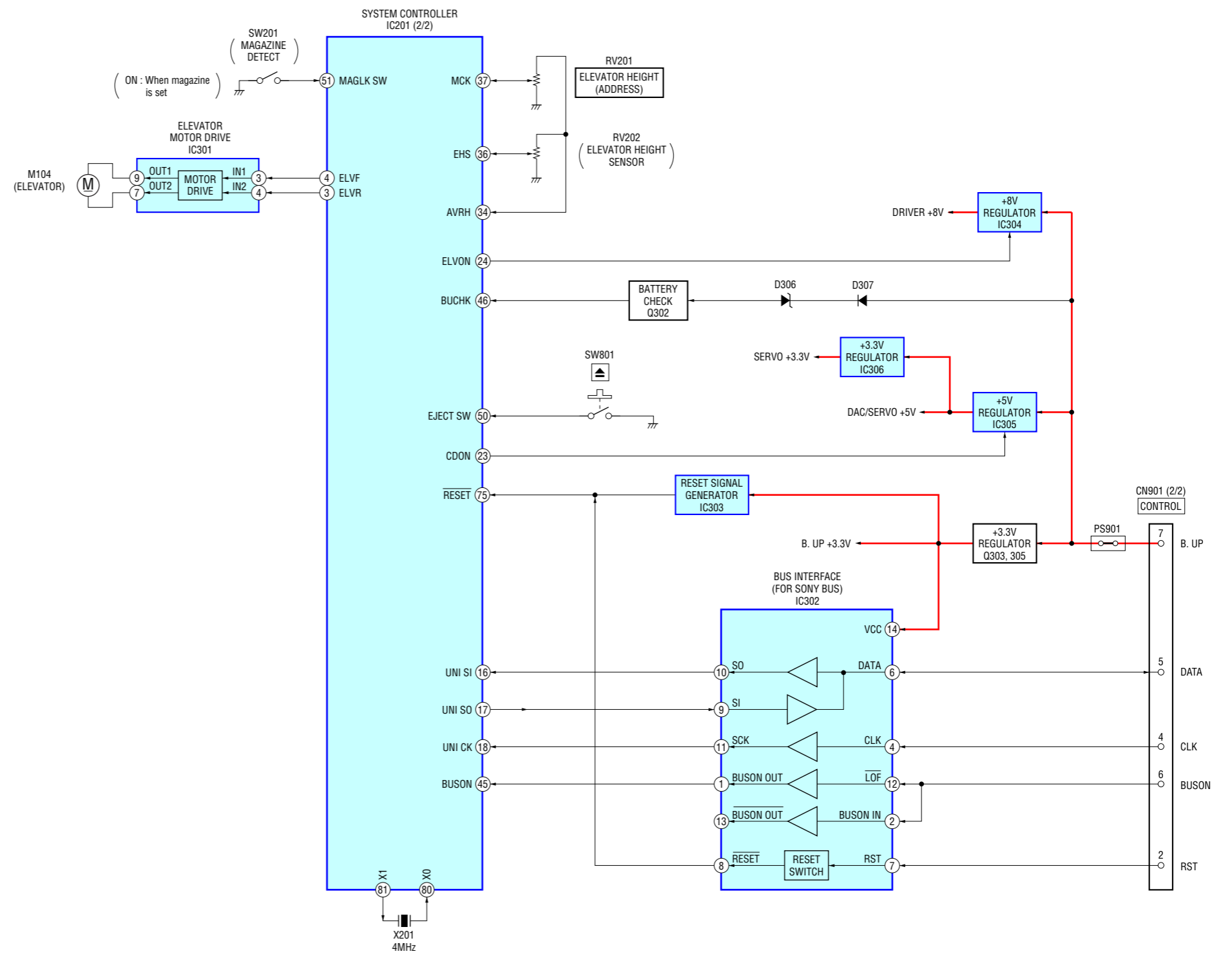


SECTION 7  
DIAGRAMS

7-1. BLOCK DIAGRAM – SERVO Section –







7-2. BLOCK DIAGRAM – BUS CONTROL/POWER SUPPLY Section –





7-3. NOTE FOR PRINTED WIRING BOARDS AND SCHEMATIC DIAGRAMS



**Note on Printed Wiring Board:**




-  : parts extracted from the component side.
-  : parts extracted from the conductor side.
-  : internal component.
-  : Pattern from the side which enables seeing.  
(The other layers' patterns are not indicated.)

Caution:  
 Pattern face side: Parts on the pattern face side seen from the pattern face are indicated.  
 (Conductor Side)  
 Parts face side: Parts on the parts face side seen from the parts face are indicated.  
 (Component Side)

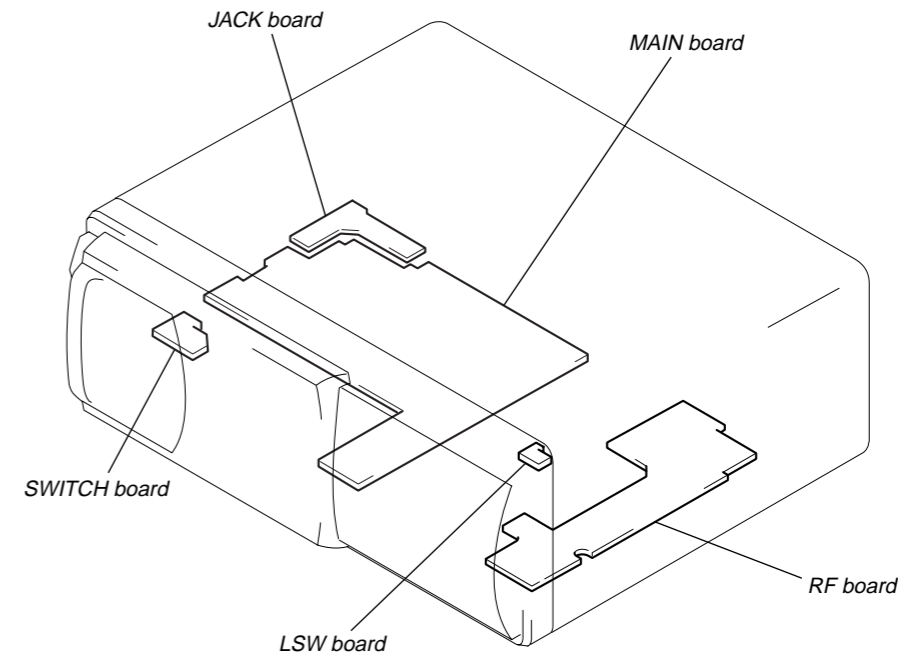
**Note on Schematic Diagram:**

- All capacitors are in  $\mu\text{F}$  unless otherwise noted. pF:  $\mu\mu\text{F}$  50 WV or less are not indicated except for electrolytics and tantalums.
- All resistors are in  $\Omega$  and  $1/4\text{W}$  or less unless otherwise specified.
-  : internal component.
-  : panel designation.

**Note:** The components identified by mark  or dotted line with mark  are critical for safety. Replace only with part number specified.

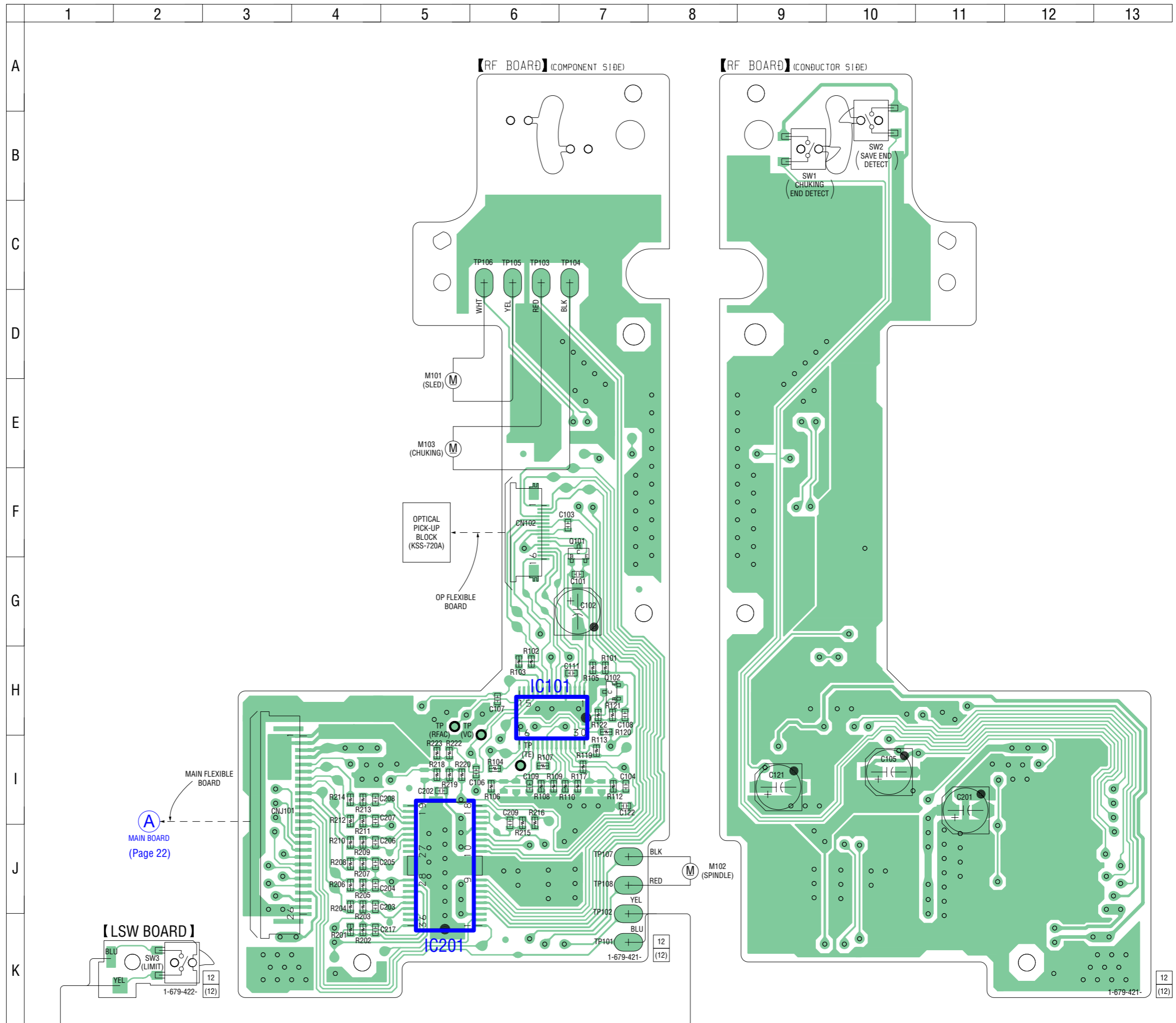
-  : B+ Line.
-  : adjustment for repair.
- Power voltage is dc 14.4V and fed with regulated dc power supply from CD changer controller.
- Voltages and waveforms are dc with respect to ground under no-signal conditions.  
no mark : CD PLAY
- Voltages are taken with a VOM (Input impedance 10 M $\Omega$ ). Voltage variations may be noted due to normal production tolerances.
- Waveforms are taken with a oscilloscope. Voltage variations may be noted due to normal production tolerances.
- Circled numbers refer to waveforms.
- Signal path.
-  : CD PLAY

• Circuit Boards Location

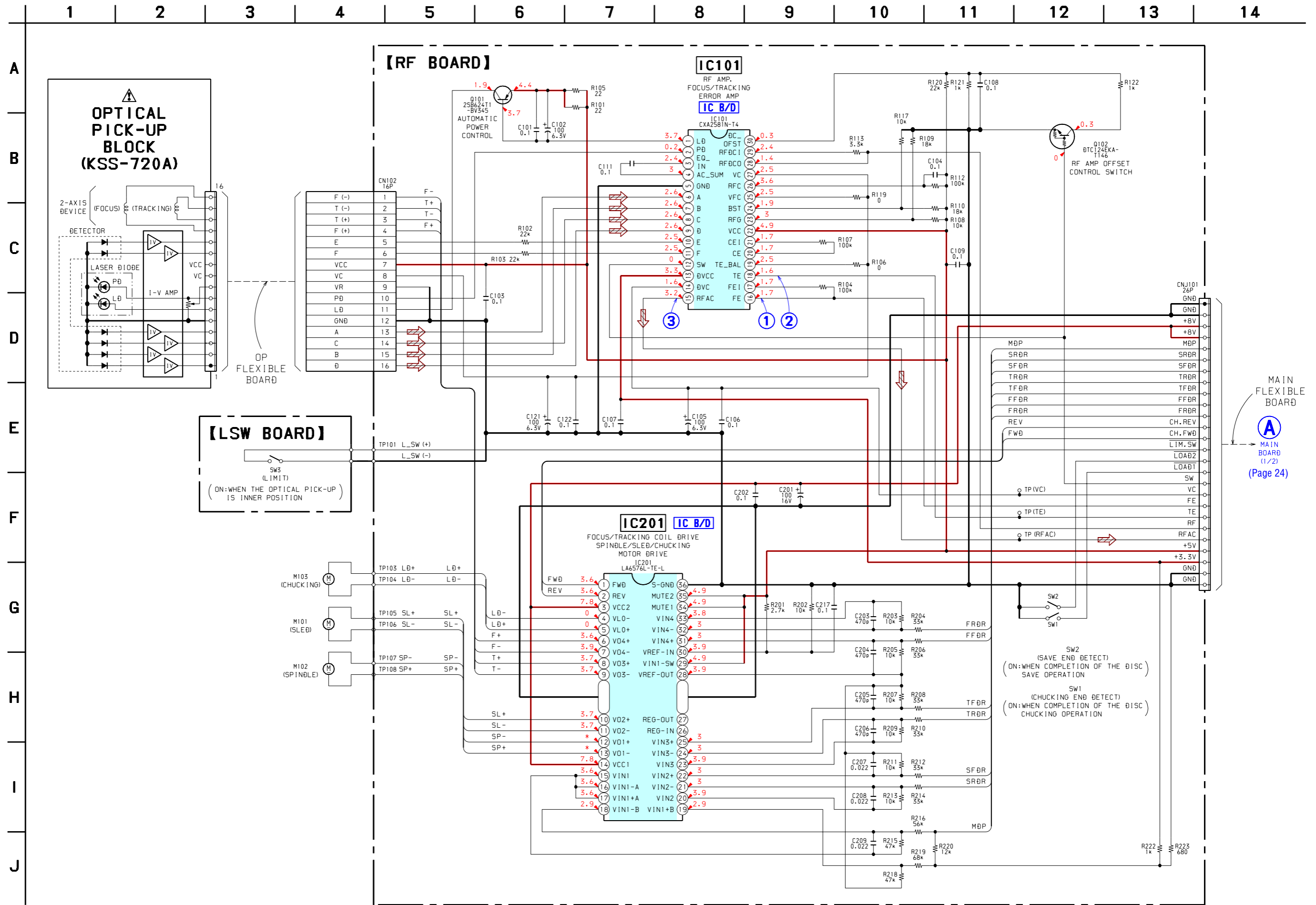


• Semiconductor Location

Ref. No.	Location
IC101	H-6
IC201	J-5
Q101	F-7
Q102	H-7



7-5. SCHEMATIC DIAGRAM – RF/LSW Boards – • See page 27 for for Waveforms. • See page 28 for IC Block Diagrams.

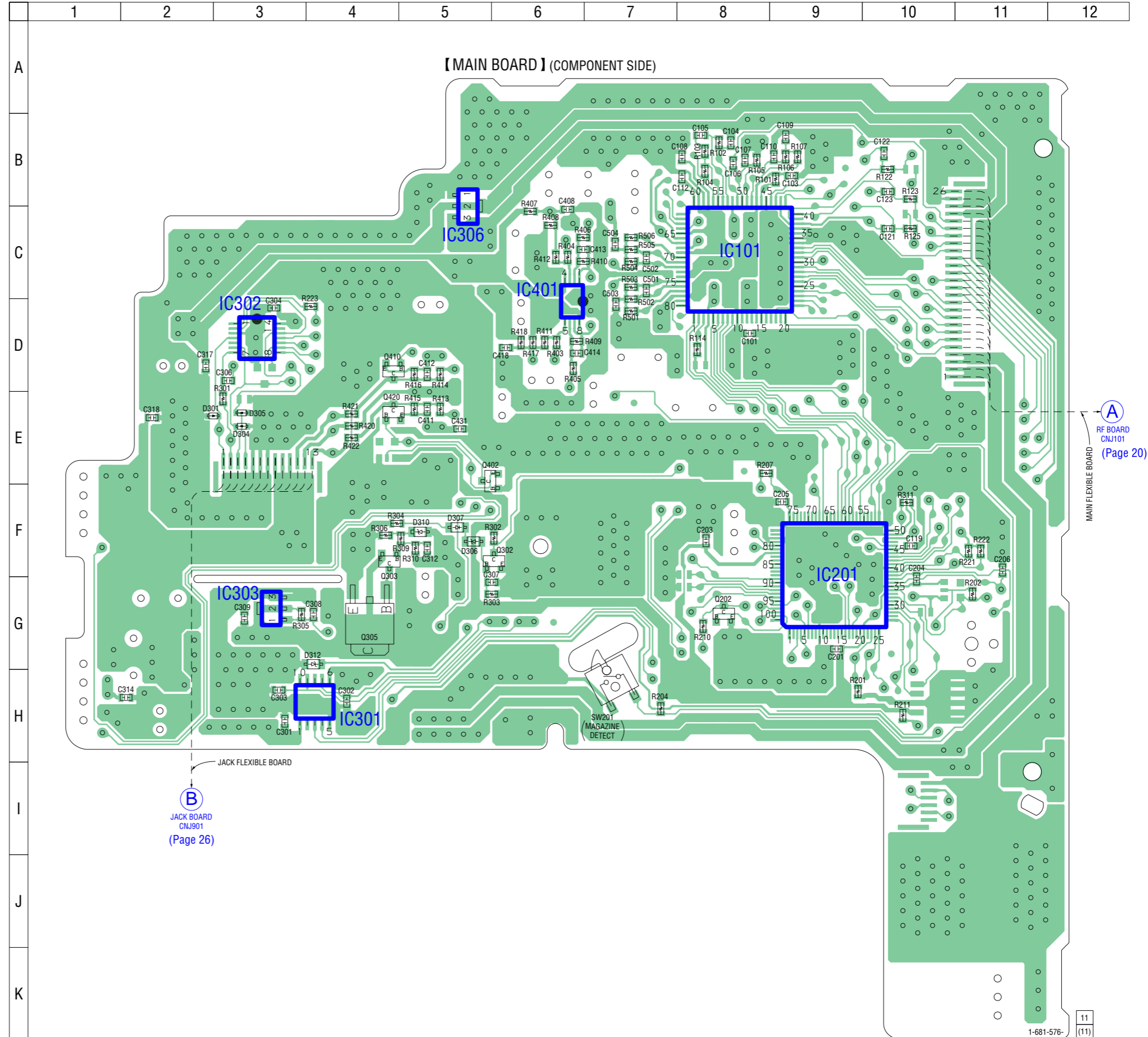


The components identified by mark  $\Delta$  or dotted line with mark  $\Delta$  are critical for safety. Replace only with part number specified.

7-6. PRINTED WIRING BOARDS – MAIN Board (Component Side) – • See page 19 for Circuit Boards Location.

• Semiconductor Location

Ref. No.	Location
D301	E-2
D304	E-3
D305	E-3
D306	F-5
D307	F-5
D310	F-5
D312	G-4
IC101	C-8
IC201	F-9
IC301	H-4
IC302	D-3
IC303	G-3
IC306	C-5
IC401	C-6
Q202	G-8
Q302	F-6
Q303	F-4
Q305	G-4
Q402	F-6
Q410	D-4
Q420	E-4

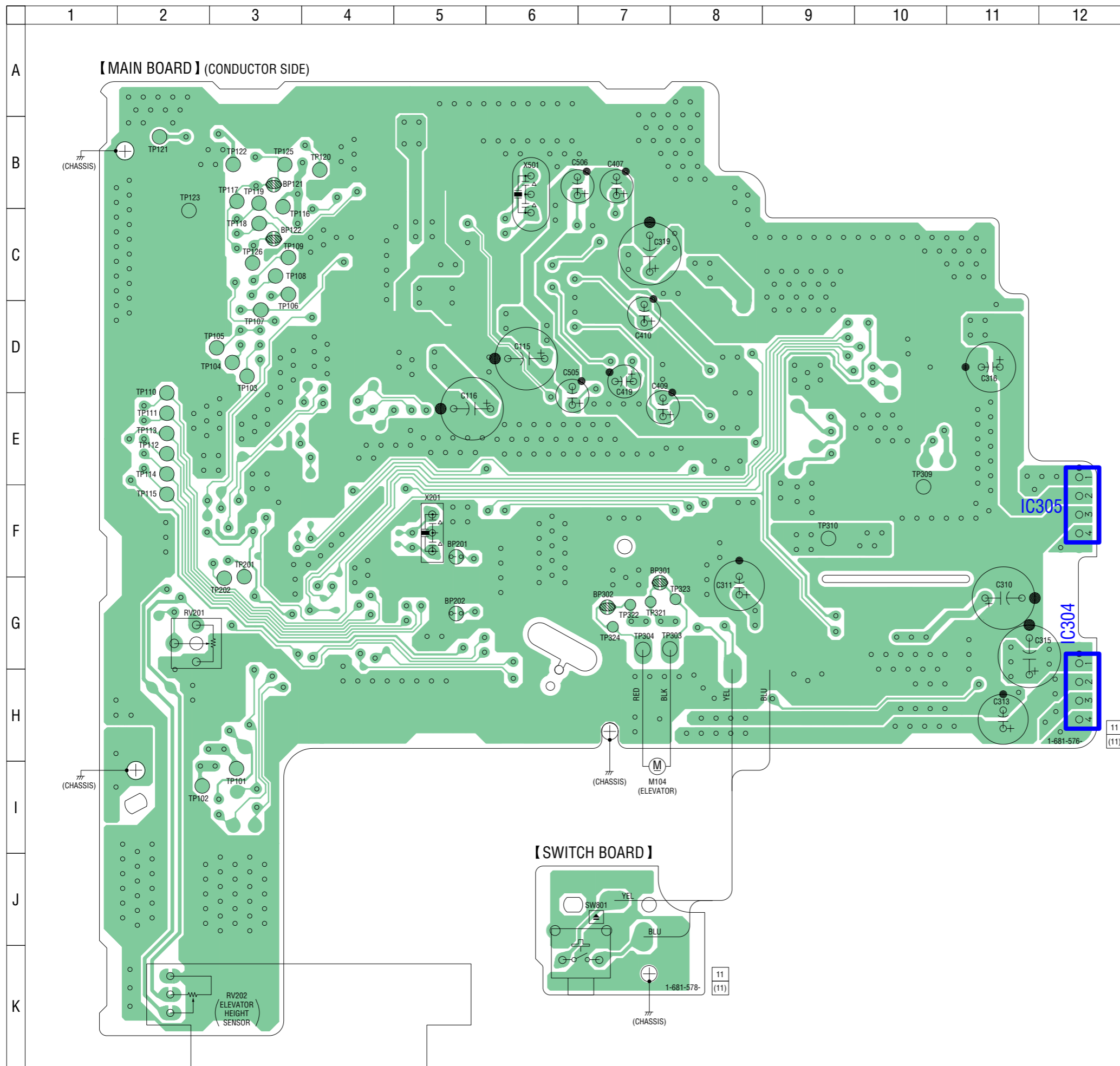


(B)  
JACK BOARD  
CNJ901  
(Page 26)

(A)  
RF BOARD  
CNJ101  
(Page 20)

MAIN FLEXIBLE BOARD

7-7. PRINTED WIRING BOARDS – MAIN (Conductor Side)/SWITCH Boards – • See page 19 for Circuit Boards Location.



• Semiconductor Location

Ref. No.	Location
IC304	H-12
IC305	F-12

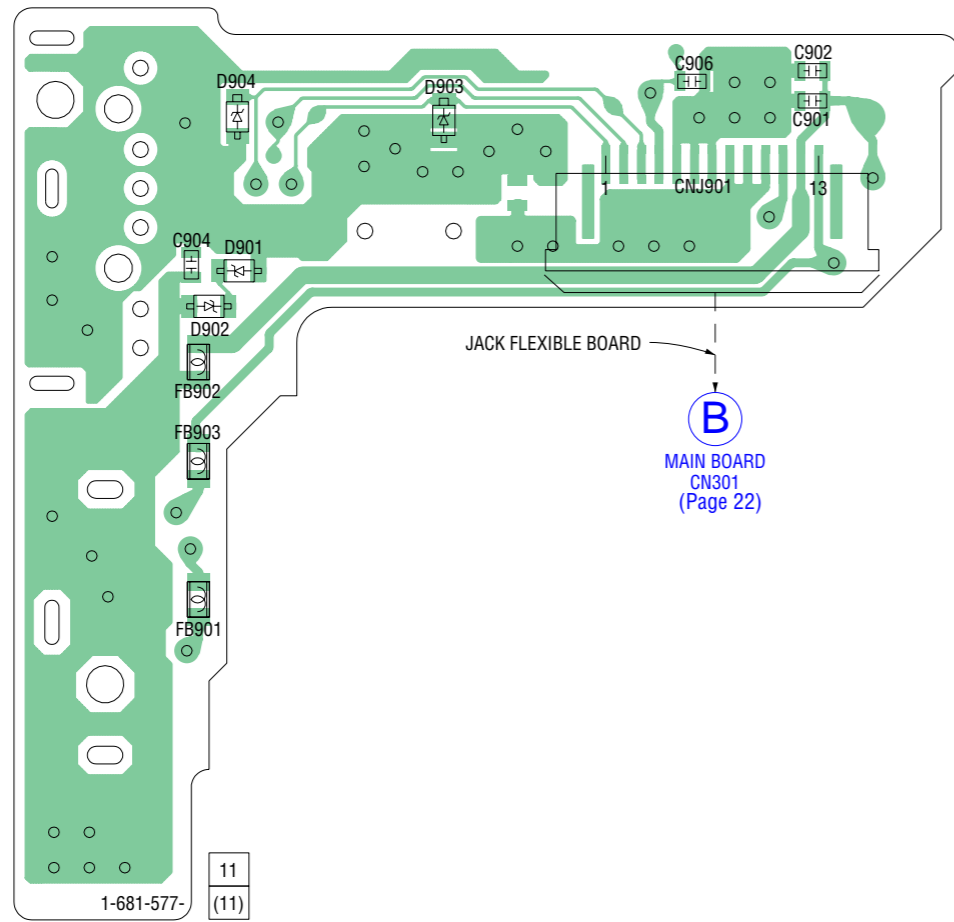




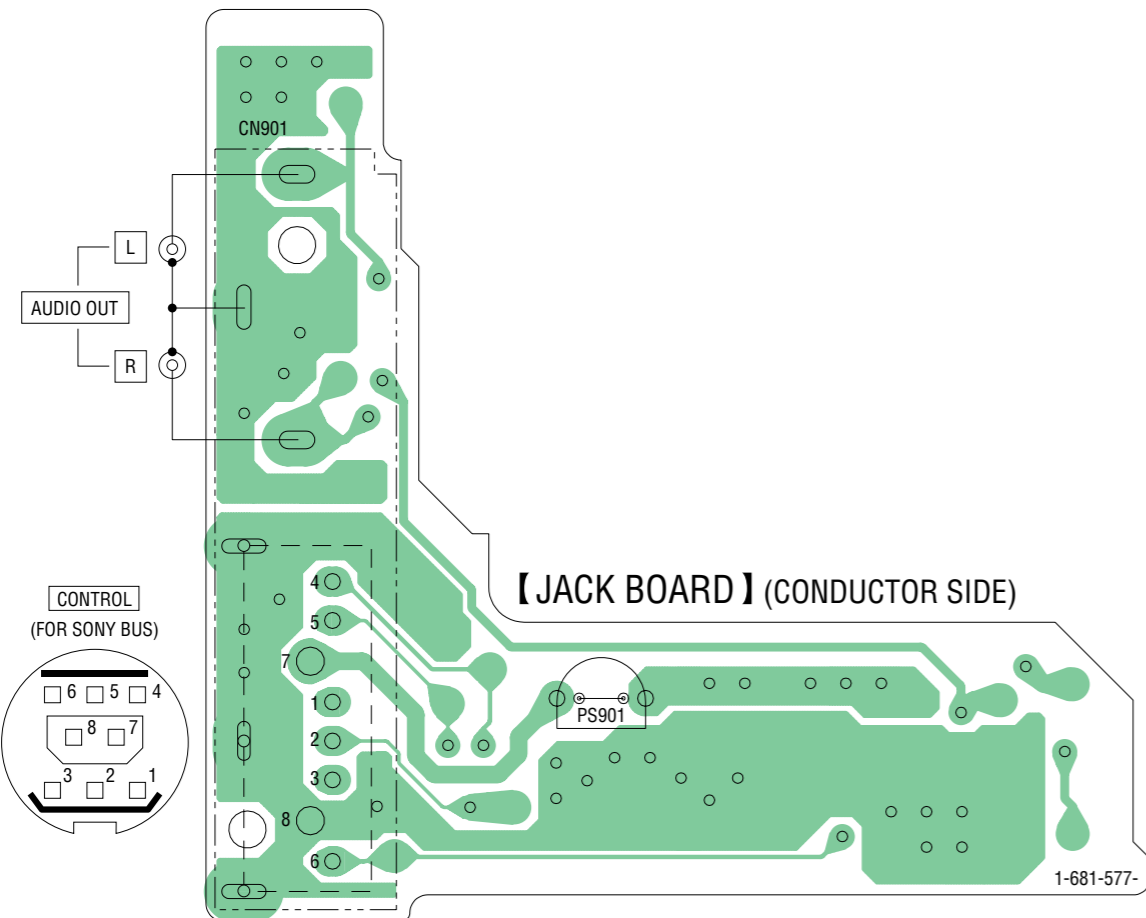
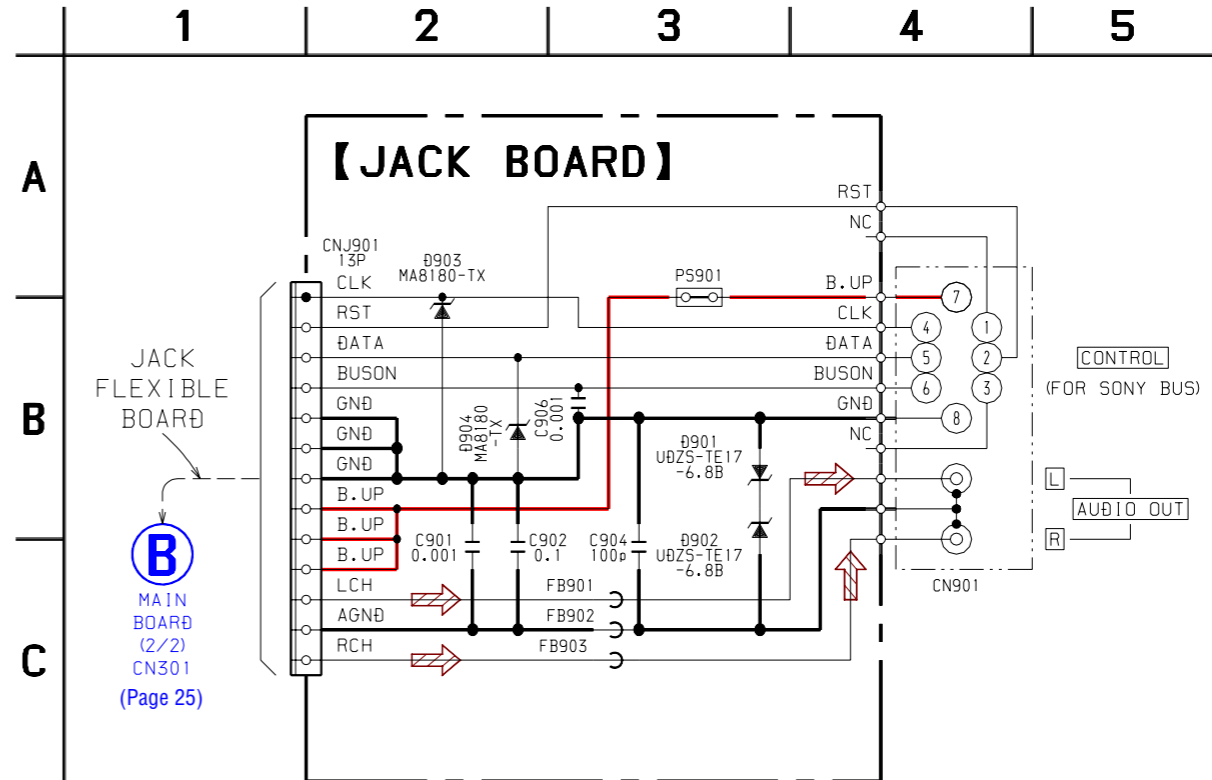


7-10. PRINTED WIRING BOARDS – JACK Board – • See page 19 for Circuit Boards Location.

【JACK BOARD】(COMPONENT SIDE)

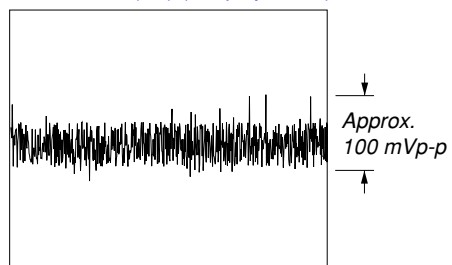


7-11. SCHEMATIC DIAGRAM – JACK Board –

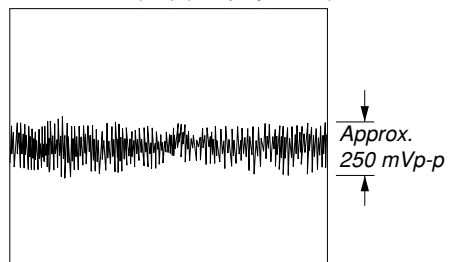


• Waveforms  
– RF Board –

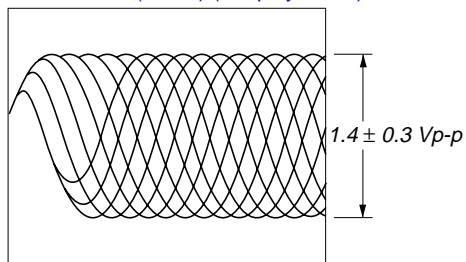
1 IC101 ⑩ (FE) (CD play mode)



2 IC101 ⑱ (TE) (CD play mode)

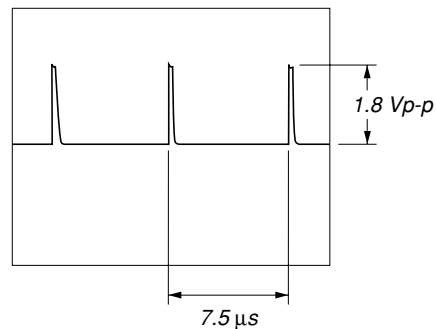


3 IC101 ⑮ (RFAC) (CD play mode)

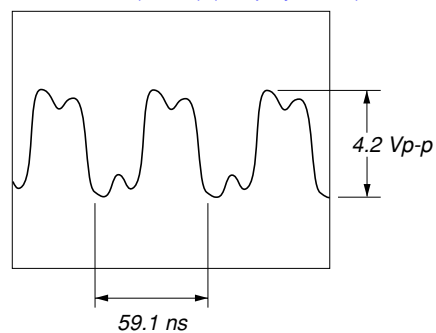


– MAIN Board –

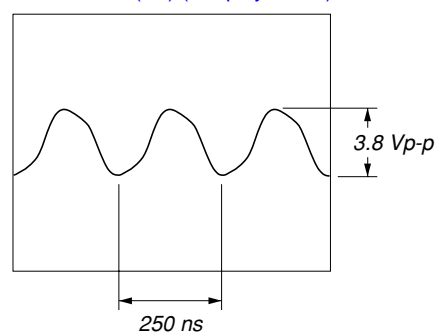
1 IC101 ⑳ (MDP) (CD play mode)



2 IC101 ⑳ (XTAO) (CD play mode)

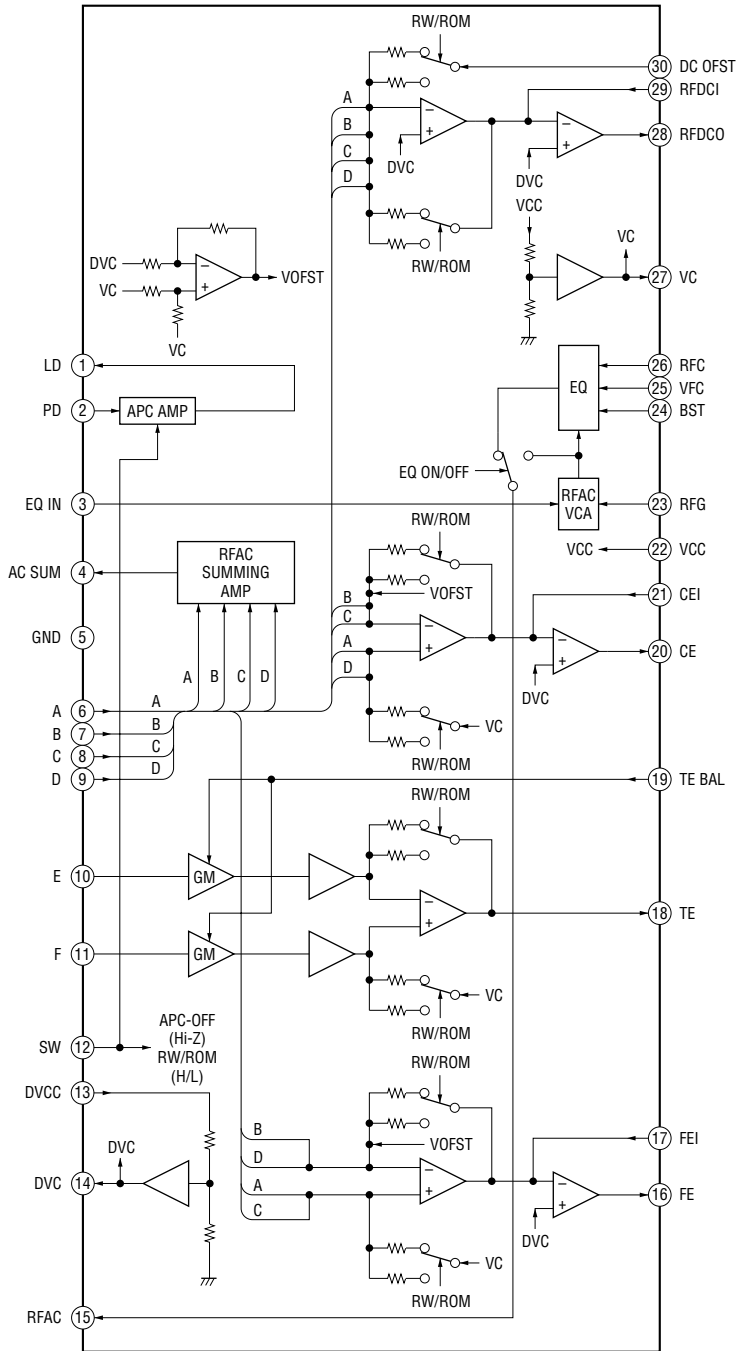


3 IC201 ㉑ (X1) (CD play mode)

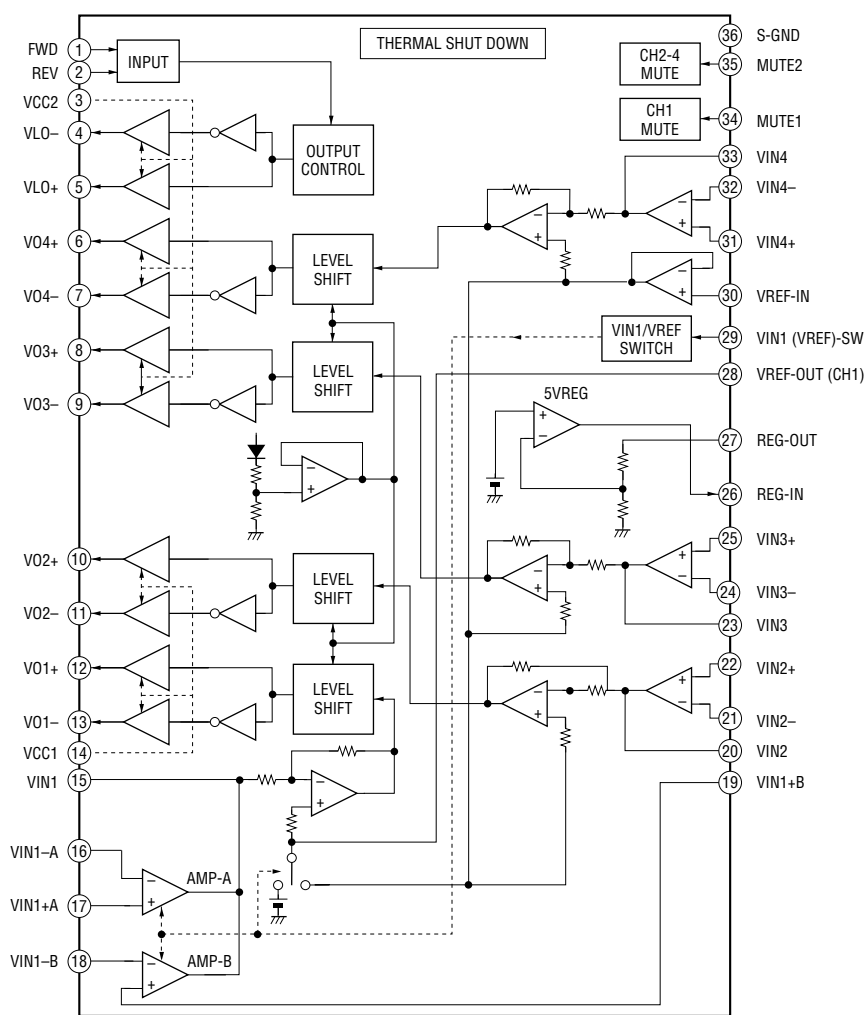


• IC Block Diagrams  
– RF Board –

IC101 CXA2581N-T4

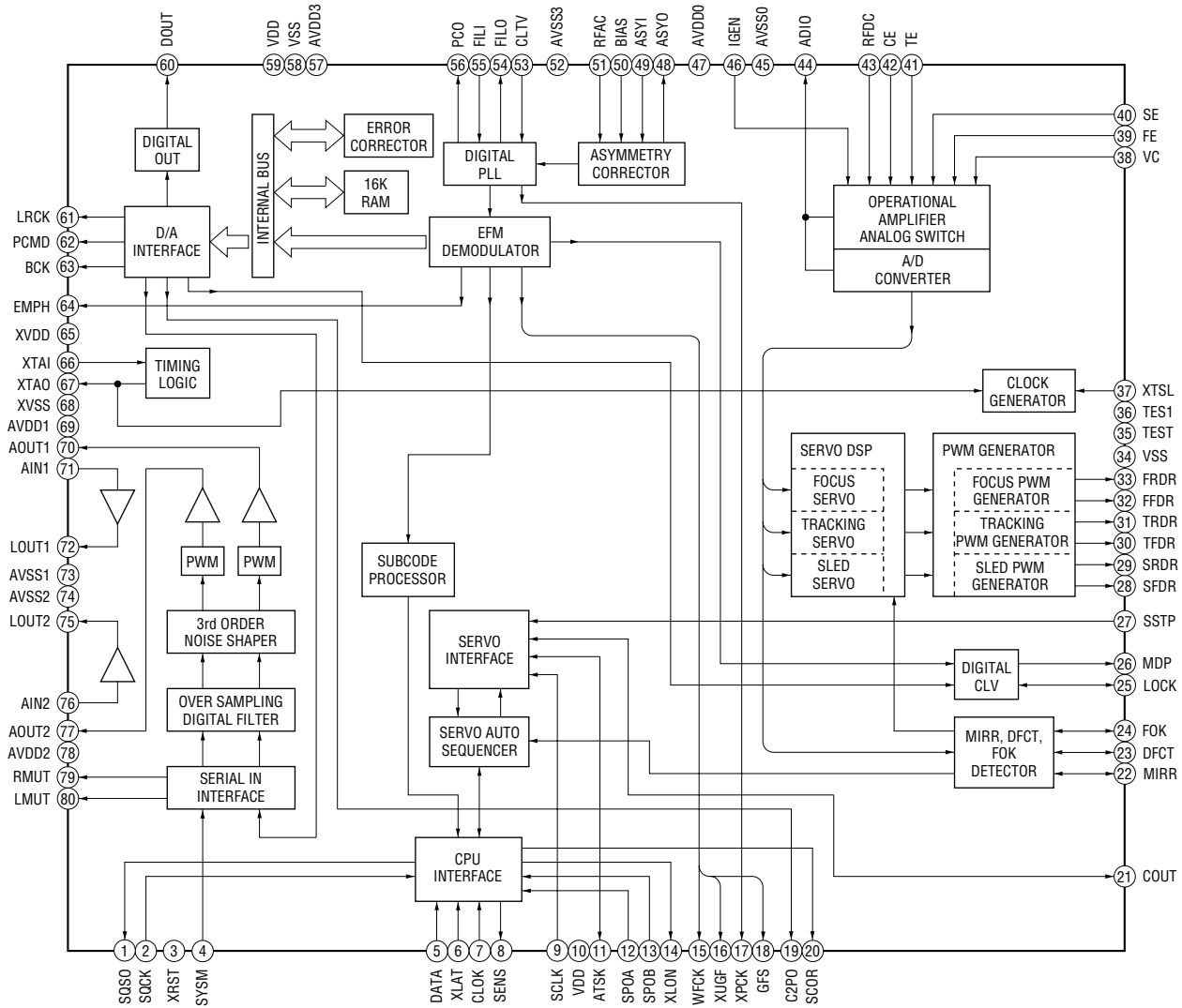


IC201 LA6576L-TE-L

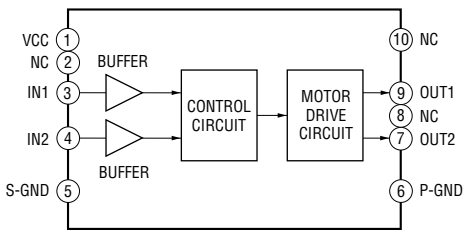


- MAIN Board -

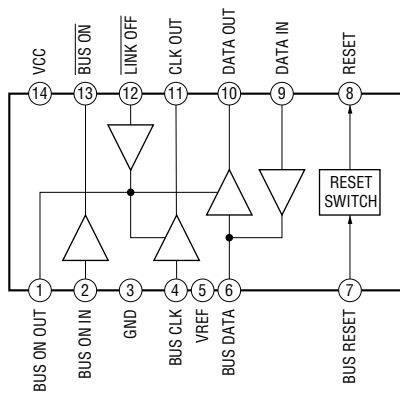
IC101 CXD3017Q



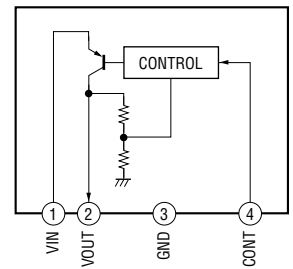
IC301 LB1930M-TLM



IC302 BA8272AFV-E2



IC304 NJM2395AF08  
IC305 NJM2395AF05



## 7-12. IC PIN FUNCTION DESCRIPTION

## • MAIN BOARD IC201 MB90473PFV-G-111-BNDE1 (SYSTEM CONTROLLER)

Pin No.	Pin Name	I/O	Description
1, 2	RAMA5, RAMA6	O	Address signal output to the S-RAM Not used (open)
3	ELVR	O	Motor drive signal (elevator down direction) output to the elevator motor drive (IC301) *1
4	ELVF	O	Motor drive signal (elevator up direction) output to the elevator motor drive (IC301) *1
5	LOADF	O	Motor drive signal (load chucking direction) output to the chucking motor drive (IC201) *2
6	LOADR	O	Motor drive signal (save direction) output to the chucking motor drive (IC201) *2
7, 8	RAMA7, RAMA12	O	Address signal output to the S-RAM Not used (open)
9	VSS	—	Ground terminal
10	RAMA14	O	Address signal output to the S-RAM Not used (open)
11	RAMWE	O	Write enable output to the S-RAM Not used (open)
12 to 15	RAMA13, RAMA8, RAMA9, RAMA11	O	Address signal output to the S-RAM Not used (open)
16	UNI SI	I	Serial data input from the SONY bus interface (IC302)
17	UNI SO	O	Serial data output to the SONY bus interface (IC302)
18	UNI CK	I	Serial data transfer clock signal input from the SONY bus interface (IC302)
19	LEDDAT	O	Not used (open)
20	LEDCLK	O	Not used (open)
21	VCC	—	Power supply terminal (+3.3V)
22	LEDLAT	O	Not used (open)
23	CDON	O	D/A converter and servo section power supply on/off control signal output “H”: power on
24	ELVON	O	Mechanism deck section power supply on/off control signal output “H”: power on
25	RX	I	Input terminal at the flash memory data write mode Not used (open)
26	TX	O	Output terminal at the flash memory data write mode Not used (open)
27	NC	O	Not used (open)
28	EECLK	O	Serial data transfer clock signal output to the EEPROM Not used (open)
29	FL BOOT	I	Flash memory data write control signal input terminal “L” active Not used (fixed at “H”)
30, 31	NC	O	Not used (open)
32	EEDAT	I/O	Two-way data bus with the EEPROM Not used (open)
33	AVCC	—	Power supply terminal (+3.3V) (for A/D converter)
34	AVRH	I	Reference voltage (+3.3V) input terminal (for A/D converter)
35	AVSS	—	Ground terminal (for A/D converter)
36	EHS	I	Elevator height position detection signal input from the RV202 (elevator height sensor) (A/D input)
37	MCK	I	Input of detection signal for the fine adjustment (elevator height (address) adjustment; RV201) of elevator height position (A/D input)
38, 39	KEY0, KEY1	I	Not used (fixed at “H”)
40	VSS	—	Ground terminal
41	FOK	I	Focus OK signal input from the CXD3017Q (IC101) “L”: NG, “H”: OK
42	GFS	I	Guard frame sync signal input from the CXD3017Q (IC101) “L”: NG, “H”: OK
43	SCLK	O	Serial data reading clock signal output to the CXD3017Q (IC101)
44	SENS	I	Internal status signal (sense signal) input from the CXD3017Q (IC101)
45	BUSON	I	Bus on/off control signal input from the SONY bus interface (IC302) “H”: bus on
46	BUCHK	I	Battery detection signal input “L”: battery on
47, 48	MD0, MD1	I	Setting terminal for the CPU operational mode (fixed at “H” in this set)
49	MD2	I	Setting terminal for the CPU operational mode (fixed at “L” in this set)
50	EJECT SW	I	Eject switch (SW801) input terminal “L” active
51	MAGLK SW	I	Magazine detect switch (SW201) input terminal “L”: magazine is set

Pin No.	Pin Name	I/O	Description
52	SCOR	I	Subcode sync (S0+S1) detection signal input from the CXD3017Q (IC101)
53	GRSCOR	I	Subcode sync (S0+S1) detection signal input terminal Not used (open)
54	NC	O	Not used (open)
55	HS	O	Normal/high speed playback control signal output terminal “L”: high speed playback Not used (open)
56	SQSO	I	Subcode Q data input from the CXD3017Q (IC101)
57	NC	O	Not used (open)
58	SQCK	O	Subcode Q data reading clock signal output to the CXD3017Q (IC101)
59	CDCLK	O	Serial data transfer clock signal output to the CXD3017Q (IC101)
60	CDLAT	O	Serial data latch pulse signal output to the CXD3017Q (IC101)
61	CDDAT	O	Serial data output to the CXD3017Q (IC101)
62	XRST	O	System reset signal output to the CXD3017Q (IC101) “L”: reset
63	XQOK	O	Subcode Q OK pulse signal output terminal Not used (open)
64	XRDE	O	D-RAM read enable signal output terminal Not used (open)
65	XWRE	O	D-RAM write enable signal output terminal Not used (open)
66	EMPH	O	Emphasis control signal output to the CXD3017Q (IC101) “H”: emphasis on
67	MUTE	O	Audio line muting on/off control signal output “H”: muting on
68	RAMA10	O	Address signal output to the S-RAM Not used (open)
69	RAMCS	O	Chip select enable output to the S-RAM Not used (open)
70 to 74	RAMIO7 to RAMIO3	I/O	Two-way data bus with the S-RAM Not used (open)
75	$\overline{\text{RESET}}$	I	System reset signal input from the SONY bus interface (IC302) and reset signal generator (IC303) “L”: reset For several hundreds msec. after the power supply rises, “L” is input, then it changes to “H”
76	RAMIO2	I/O	Two-way data bus with the S-RAM Not used (open)
77	X1A	O	Sub system clock output terminal Not used (open)
78	X0A	I	Sub system clock input terminal Not used (fixed at “L”)
79	VSS	—	Ground terminal
80	X0	I	Main system clock input terminal (4 MHz)
81	X1	O	Main system clock output terminal (4 MHz)
82	VCC	—	Power supply terminal (+3.3V)
83, 84	RAMIO1, RAMIO0	I/O	Two-way data bus with the S-RAM Not used (open)
85 to 88	RAMA0 to RAMA3	O	Address signal output to the S-RAM Not used (open)
89	$\overline{\text{SINGLE}}$	I	Setting terminal for the single disc/multiple discs mode “L”: single disc mode, “H”: multiple discs mode (fixed at “H”)
90	$\overline{6/10 \text{ SEL}}$	I	Setting terminal for the 6 discs changer/10 discs changer model “L”: 10 discs changer model, “H”: 6 discs changer model Not used (open)
91	CFSEL	I	Custom file on/off setting terminal “L”: custom file on Not used (fixed at “H”)
92	TEXTSEL	I	CD text mode setting terminal “L”: CD text on, “H”: does not display track name Not used (fixed at “H”)
93	ESPSEL	I	ESP mode setting terminal “L”: ESP on Not used (open)
94	TEST	I	Test on/off setting terminal “L”: test mode Not used (fixed at “H”)
95	MAG SW	I	Magazine in/out detect switch input terminal Not used (open)
96	$\overline{\text{SAVE SW}}$	I	Save end detect switch (SW2) input terminal “L”: When completion of the disc save operation
97	$\overline{\text{LOAD SW}}$	I	Chucking end detect switch (SW1) input terminal “L”: When completion of the disc chucking operation



Pin No.	Pin Name	I/O	Description
98	$\overline{\text{LIM SW}}$	I	Sled limit in detect switch (SW3) input terminal “L”: When the optical pick-up is inner position
99	RW SEL	O	CD-ROM/RW selection signal output “L”: CD-RW, “H”: CD-ROM
100	RAMA4	O	Address signal output to the S-RAM Not used (open)

\*1 elevator motor (M104) control

Terminal \ Mode	STOP	ELEVATOR UP	ELEVATOR DOWN	BRAKE
ELVF (pin ④)	“L”	“L”	“H”	“H”
ELVR (pin ③)	“L”	“H”	“L”	“H”

\*2 chucking motor (M103) control

Terminal \ Mode	STOP	LOAD CHUCKING	SAVE	BRAKE
LOADF (pin ⑤)	“L”	“L”	“H”	“H”
LOADR (pin ⑥)	“L”	“H”	“L”	“H”

## SECTION 8 EXPLODED VIEWS

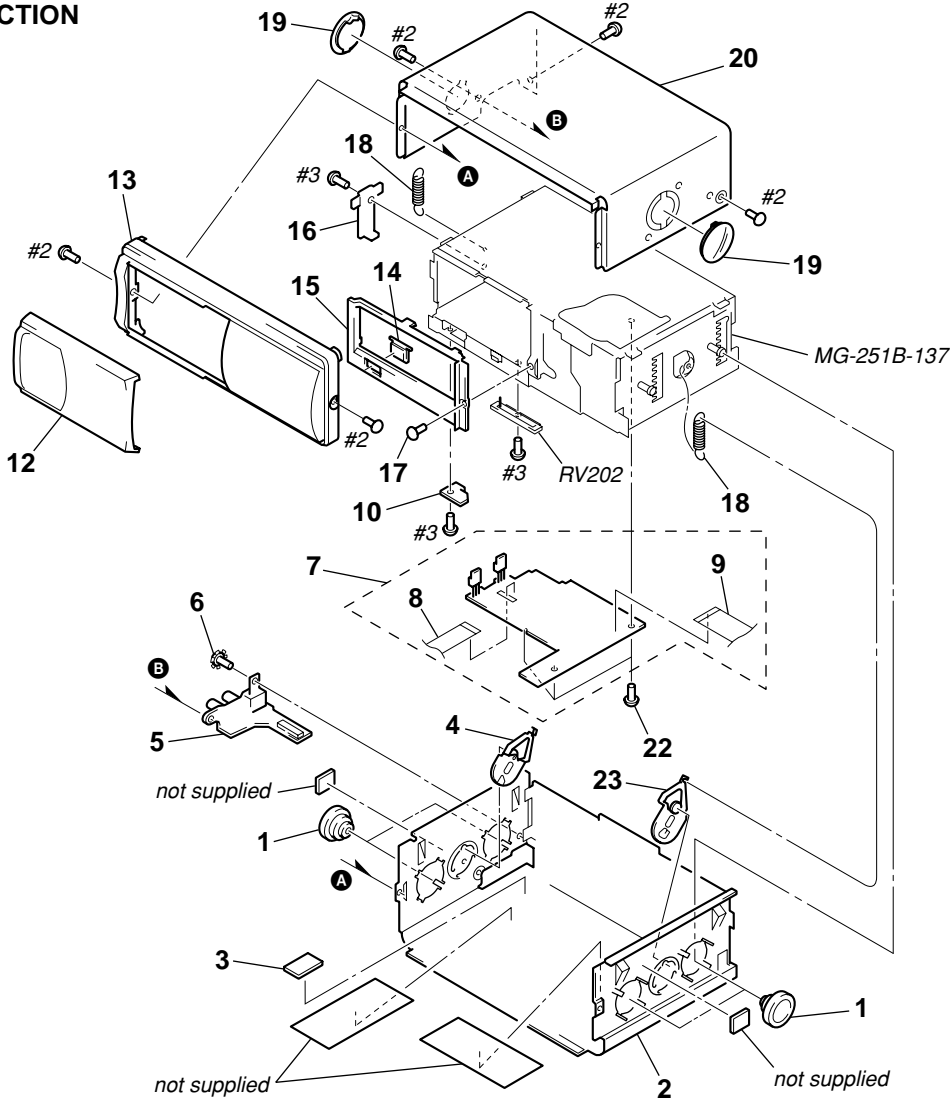
**NOTE:**

- -XX and -X mean standardized parts, so they may have some difference from the original one.
- Color Indication of Appearance Parts  
Example:  
KNOB, BALANCE (WHITE) . . . (RED)  
                                  ↑                                  ↑  
                                  Parts Color Cabinet's Color

- Items marked “\*” are not stocked since they are seldom required for routine service. Some delay should be anticipated when ordering these items.
- The mechanical parts with no reference number in the exploded views are not supplied.
- Hardware (# mark) list and accessories and packing materials are given in the last of the electrical parts list.

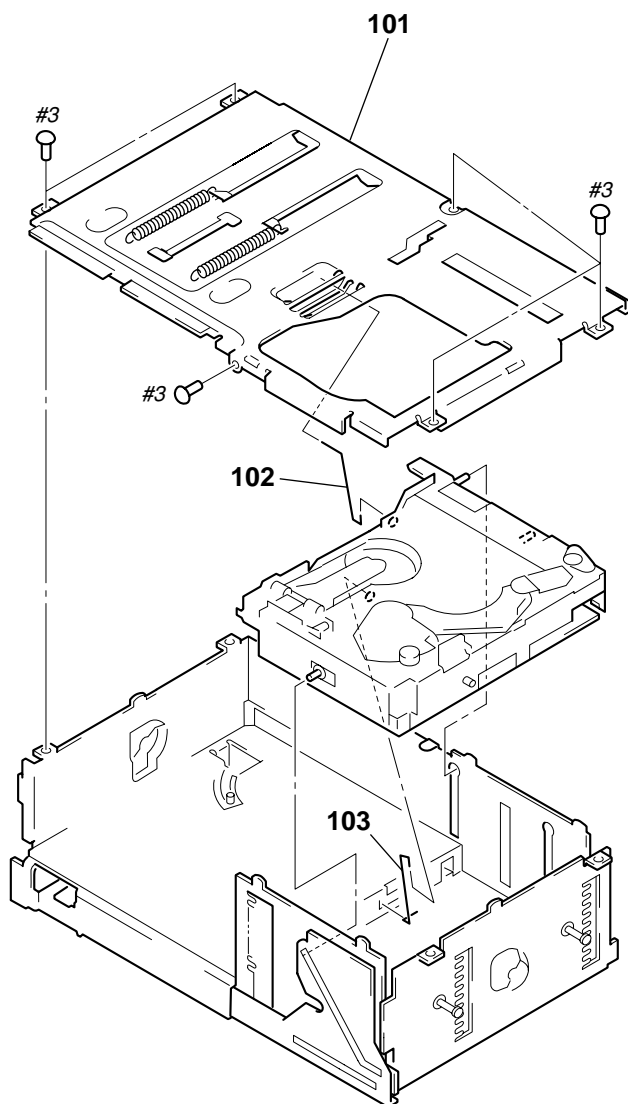
The components identified by mark  $\triangle$  or dotted line with mark  $\triangle$  are critical for safety. Replace only with part number specified.

**8-1. CASE SECTION**



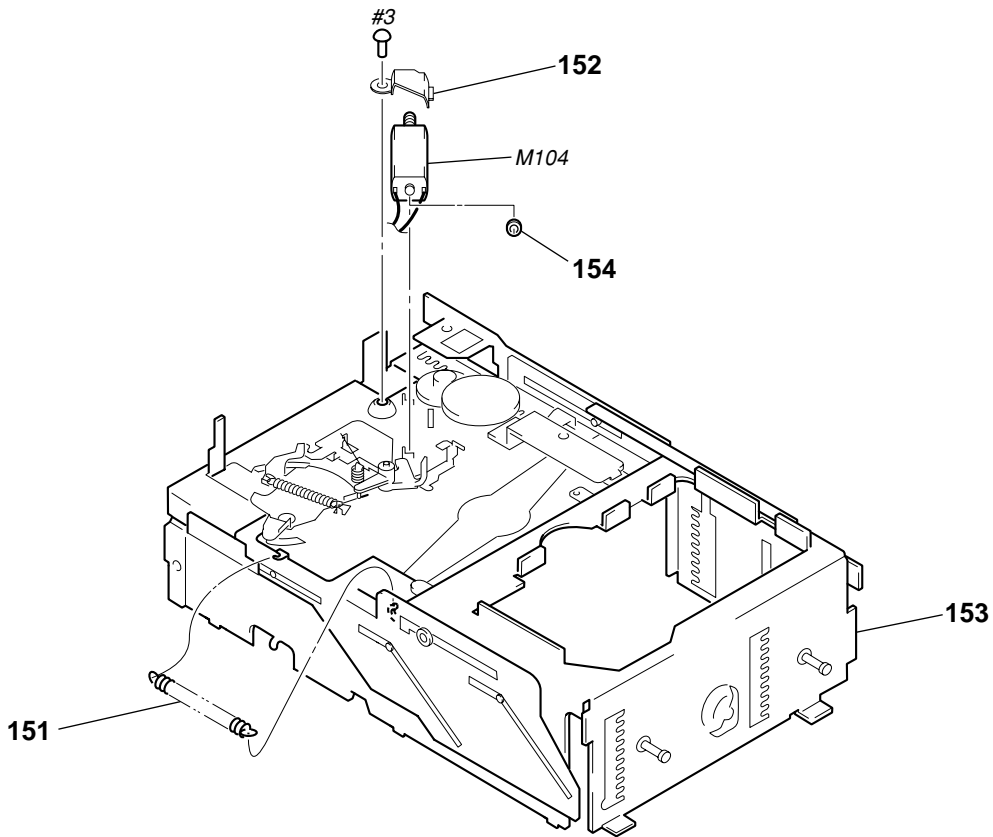
Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
1	3-047-852-01	DAMPER (T)		14	3-022-007-02	BUTTON (EJT) ( $\triangle$ )	
2	3-045-543-81	CASE (LOWER. T)		15	3-041-218-21	ESCUTCHEON (T)	
* 3	3-024-065-01	CUSHION (EJECT-T)		* 16	3-022-012-01	HEAT SINK (T)	
4	X-3375-357-1	ARM (FLT) ASSY		17	3-042-244-11	SCREW (T)	
5	1-681-577-11	JACK BOARD		18	3-038-166-01	SPRING (FL), TENSION COIL	
6	3-376-464-11	SCREW (+PTT 2.6X6), GROUND POINT		19	3-047-886-11	LEVER (FLT. 838)	
7	A-3283-194-A	MAIN BOARD, COMPLETE		20	3-046-160-81	CASE (UPPER. T)	
8	1-676-340-12	JACK FLEXIBLE BOARD		22	3-935-636-11	SCREW (FP)	
9	1-676-339-12	MAIN FLEXIBLE BOARD		23	X-3375-360-2	ARM (FRT) ASSY	
10	1-681-578-11	SWITCH BOARD		RV202	1-227-137-11	RES, VAR, SLIDE 10K (ELEVATOR HEIGHT SENSOR)	
12	X-3379-707-1	DOOR (L) ASSY					
13	3-224-392-21	PANEL (L), FRONT					

8-2. MECHANISM DECK SECTION-1  
(MG-251B-137)



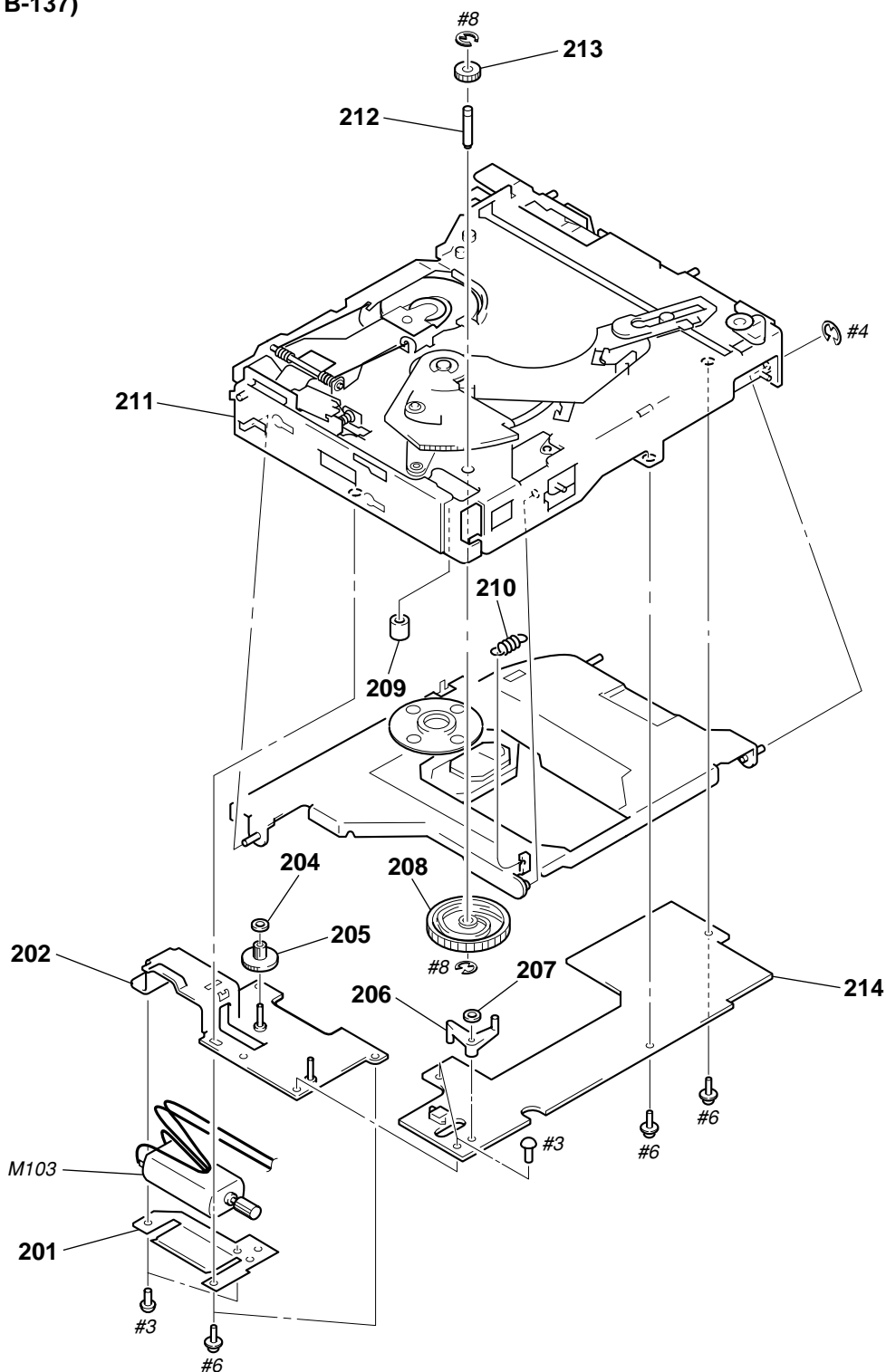
<u>Ref. No.</u>	<u>Part No.</u>	<u>Description</u>	<u>Remark</u>	<u>Ref. No.</u>	<u>Part No.</u>	<u>Description</u>	<u>Remark</u>
101	X-3378-091-1	CHASSIS (U. S) SUB ASSY		103	3-011-997-01	SPRING (STOPPER. LOWER)	
102	3-024-161-01	SPRING (SUT)					

8-3. MECHANISM DECK SECTION-2  
(MG-251B-137)



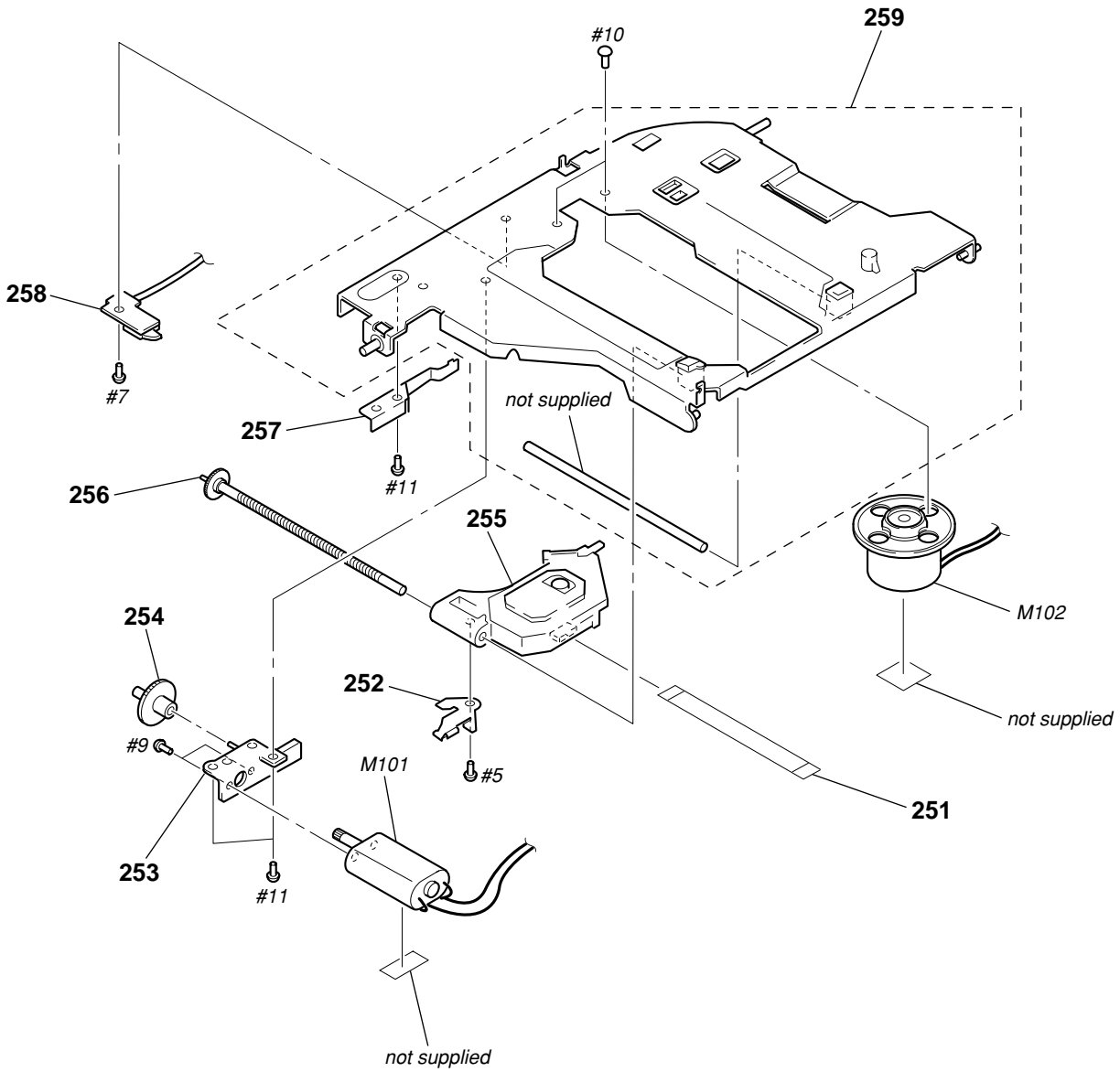
Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
151	3-024-170-01	SPRING (SB), TENSION		* 154	3-014-685-01	SPACER (M0)	
* 152	3-040-790-02	BRACKET (EVM. S)		M104	A-3301-123-A	ELJ MOTOR ASSY (ELEVATOR)	
153	X-3378-092-6	CHASSIS (D. S) SUB ASSY					

8-4. MECHANISM DECK SECTION-3  
(MG-251B-137)



Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
* 201	3-024-150-01	RETAINER (CHM)		209	3-010-252-11	ROLLER (CRE)	
* 202	X-3378-080-1	BRACKET (CHM. D) ASSY		210	3-010-268-01	SPRING (DH), TENSION	
204	3-321-813-01	WASHER, COTTER POLYETHYLENE		* 211	A-3290-194-L	MAIN ASSY, CHASSIS (EVY)	
205	3-017-139-01	GEAR (WORM LOAD A)		212	3-010-254-11	SHAFT (ROTARY PREVENTION C)	
206	3-022-839-02	ARM (NSW)		213	3-010-253-01	GEAR (LOMINI)	
207	3-573-936-00	STOPPER, REEL		* 214	A-3326-947-A	RF BOARD, COMPLETE	
208	X-3373-552-1	GEAR (LOAD CAM) ASSY		M103	A-3301-123-A	ELJ MOTOR ASSY (CHUCKING)	

8-5. MECHANISM DECK SECTION-4  
(MG-251B-137)



The components identified by mark  $\triangle$  or dotted line with mark  $\triangle$  are critical for safety. Replace only with part number specified.

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
251	1-676-341-11	OP FLEXIBLE BOARD		257	3-010-263-01	DETENT (SHAFT THRUST)	
252	3-025-743-01	SPRING (FEED), LEAF		* 258	1-679-422-12	LSW BOARD	
253	X-3378-101-1	HOLDER (SLED. S) ASSY		259	A-3301-954-B	BASE (OPT. S) (J) ASSY	
254	3-931-832-01	GEAR (SL MIDWAY)		M101	A-3315-151-A	SLED MOTOR ASSY (251)	
$\triangle$ 255	8-820-103-11	OPTICAL PICK-UP KSS-720A/C-RP		M102	A-3301-998-A	SPINDLE MOTOR (S) SUB ASSY	
256	A-3291-669-A	SHAFT (FEED) ASSY					

## SECTION 9 ELECTRICAL PARTS LIST

<b>JACK</b>	<b>MAIN</b>
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**NOTE:**

- Due to standardization, replacements in the parts list may be different from the parts specified in the diagrams or the components used on the set.
- -XX and -X mean standardized parts, so they may have some difference from the original one.
- RESISTORS  
All resistors are in ohms.  
METAL: Metal-film resistor.  
METAL OXIDE: Metal oxide-film resistor.  
F: nonflammable

- Items marked “\*” are not stocked since they are seldom required for routine service. Some delay should be anticipated when ordering these items.
- SEMICONDUCTORS  
In each case, u:  $\mu$ , for example:  
uA. . . :  $\mu$ A. . .      uPA. . . :  $\mu$ PA. . .  
uPB. . . :  $\mu$ PB. . .    uPC. . . :  $\mu$ PC. . .  
uPD. . . :  $\mu$ PD. . .
- CAPACITORS  
uF:  $\mu$ F
- COILS  
uH:  $\mu$ H

The components identified by mark  $\Delta$  or dotted line with mark  $\Delta$  are critical for safety. Replace only with part number specified.

When indicating parts by reference number, please include the board.

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
	1-681-577-11	JACK BOARD *****					
		< CAPACITOR >					
C901	1-162-964-11	CERAMIC CHIP	0.001uF 10% 50V	C115	1-115-466-11	ELECT	1000uF 20% 16V
C902	1-164-156-11	CERAMIC CHIP	0.1uF 25V	C119	1-164-156-11	CERAMIC CHIP	0.1uF 25V
C904	1-162-927-11	CERAMIC CHIP	100PF 5% 50V	C121	1-162-960-11	CERAMIC CHIP	220PF 10% 50V
C906	1-162-964-11	CERAMIC CHIP	0.001uF 10% 50V	C122	1-162-960-11	CERAMIC CHIP	220PF 10% 50V
		< CONNECTOR >		C123	1-107-826-11	CERAMIC CHIP	0.1uF 10% 16V
CN901	1-779-077-51	PLUG, CONNECTOR (CONTROL, AUDIO OUT)		C201	1-164-156-11	CERAMIC CHIP	0.1uF 25V
CNJ901	1-778-775-21	CONNECTOR, FPC 13P		C203	1-164-156-11	CERAMIC CHIP	0.1uF 25V
		< DIODE >		C204	1-164-156-11	CERAMIC CHIP	0.1uF 25V
D901	8-719-978-33	DIODE DTZ-TT11-6.8B		C205	1-107-826-11	CERAMIC CHIP	0.1uF 10% 16V
D902	8-719-978-33	DIODE DTZ-TT11-6.8B		C206	1-164-156-11	CERAMIC CHIP	0.1uF 25V
D903	8-719-017-94	DIODE MA8180		C301	1-164-156-11	CERAMIC CHIP	0.1uF 25V
D904	8-719-017-94	DIODE MA8180		C302	1-164-156-11	CERAMIC CHIP	0.1uF 25V
		< FERRITE BEAD >		C303	1-164-156-11	CERAMIC CHIP	0.1uF 25V
FB901	1-500-445-21	FERRITE	0uH	C304	1-164-156-11	CERAMIC CHIP	0.1uF 25V
FB902	1-500-445-21	FERRITE	0uH	C306	1-162-968-11	CERAMIC CHIP	0.0047uF 10% 50V
FB903	1-500-445-21	FERRITE	0uH	C307	1-128-934-11	CERAMIC CHIP	0.33uF 20% 10V
		< IC LINK >		C308	1-107-826-11	CERAMIC CHIP	0.1uF 10% 16V
PS901	1-532-686-21	LINK, IC		C309	1-162-970-11	CERAMIC CHIP	0.01uF 10% 25V
*****				C310	1-115-466-00	ELECT	1000uF 20% 16V
	A-3283-194-A	MAIN BOARD, COMPLETE *****		C311	1-125-972-61	ELECT	100uF 20% 16V
	1-676-339-12	MAIN FLEXIBLE BOARD		C312	1-107-826-11	CERAMIC CHIP	0.1uF 10% 16V
	1-676-340-12	JACK FLEXIBLE BOARD		C313	1-125-972-61	ELECT	100uF 20% 16V
		< CAPACITOR >		C314	1-164-156-11	CERAMIC CHIP	0.1uF 25V
C101	1-164-156-11	CERAMIC CHIP	0.1uF 25V	C315	1-115-466-00	ELECT	1000uF 20% 16V
C103	1-164-156-11	CERAMIC CHIP	0.1uF 25V	C316	1-125-972-61	ELECT	100uF 20% 16V
C104	1-162-965-11	CERAMIC CHIP	0.0015uF 10% 50V	C317	1-164-156-11	CERAMIC CHIP	0.1uF 25V
C105	1-165-176-11	CERAMIC CHIP	0.047uF 10% 16V	C318	1-164-156-11	CERAMIC CHIP	0.1uF 25V
C106	1-162-967-11	CERAMIC CHIP	0.0033uF 10% 50V	C319	1-128-499-11	ELECT	220uF 20% 16V
C107	1-162-960-11	CERAMIC CHIP	220PF 10% 50V	C407	1-124-589-11	ELECT	47uF 20% 16V
C108	1-164-156-11	CERAMIC CHIP	0.1uF 25V	C408	1-164-156-11	CERAMIC CHIP	0.1uF 25V
C109	1-162-970-11	CERAMIC CHIP	0.01uF 10% 25V	C409	1-126-157-11	ELECT	10uF 20% 16V
C110	1-125-837-11	CERAMIC CHIP	1uF 10% 6.3V	C410	1-126-157-11	ELECT	10uF 20% 16V
C112	1-164-156-11	CERAMIC CHIP	0.1uF 25V	C411	1-162-927-11	CERAMIC CHIP	100PF 5% 50V
				C412	1-162-927-11	CERAMIC CHIP	100PF 5% 50V
				C413	1-162-927-11	CERAMIC CHIP	100PF 5% 50V
				C414	1-162-927-11	CERAMIC CHIP	100PF 5% 50V
				C418	1-164-156-11	CERAMIC CHIP	0.1uF 25V
				C419	1-124-589-11	ELECT	47uF 20% 16V
				C431	1-162-964-11	CERAMIC CHIP	0.001uF 10% 50V
				C501	1-162-927-11	CERAMIC CHIP	100PF 5% 50V
				C502	1-162-927-11	CERAMIC CHIP	100PF 5% 50V
				C503	1-162-964-11	CERAMIC CHIP	0.001uF 10% 50V
				C504	1-162-964-11	CERAMIC CHIP	0.001uF 10% 50V

**MAIN**   **LSW**   **RF**

Ref. No.	Part No.	Description	Remark
C505	1-124-589-11	ELECT 47uF 20%	16V
C506	1-124-589-11	ELECT 47uF 20%	16V
< DIODE >			
D301	8-719-071-34	DIODE RB521S-30-TE61	
D304	8-719-071-34	DIODE RB521S-30-TE61	
D305	8-719-071-34	DIODE RB521S-30-TE61	
D306	8-719-069-56	DIODE UDZSTE-176.2B	
D307	8-719-988-61	DIODE 1SS355TE-17	
D310	8-719-977-03	DIODE DTZ5.6B	
D312	8-719-978-33	DIODE DTZ-TT11-6.8B	
< IC >			
IC101	8-752-402-31	IC CXD3017Q	
IC201	6-800-418-01	IC MB90473PFV-G-111-BNDE1	
IC301	8-759-527-33	IC LB1930M-TLM	
IC302	8-759-829-46	IC BA8272AFV-E2	
IC303	8-759-827-97	IC XC61CN2502PR	
IC304	8-759-833-13	IC NJM2395AF08	
IC305	8-759-833-12	IC NJM2395AF05	
IC306	8-759-444-93	IC RH5RL33AA-T1	
IC401	8-759-662-11	IC TLV2362IPWR	
< TRANSISTOR >			
Q202	8-729-901-00	TRANSISTOR DTC124EK	
Q302	8-729-230-49	TRANSISTOR 2SC2712-YG	
Q303	8-729-230-49	TRANSISTOR 2SC2712-YG	
Q305	8-729-822-84	TRANSISTOR 2SB1202FAST	
Q402	8-729-027-23	TRANSISTOR DTA114EKA-T146	
Q410	8-729-015-39	TRANSISTOR DTC323TK	
Q420	8-729-015-39	TRANSISTOR DTC323TK	
< RESISTOR >			
R101	1-216-839-11	METAL CHIP 33K 5%	1/16W
R102	1-216-833-11	METAL CHIP 10K 5%	1/16W
R103	1-216-827-11	METAL CHIP 3.3K 5%	1/16W
R104	1-216-827-11	METAL CHIP 3.3K 5%	1/16W
R105	1-216-857-11	METAL CHIP 1M 5%	1/16W
R106	1-216-853-11	METAL CHIP 470K 5%	1/16W
R107	1-216-833-11	METAL CHIP 10K 5%	1/16W
R114	1-216-821-11	METAL CHIP 1K 5%	1/16W
R122	1-216-839-11	METAL CHIP 33K 5%	1/16W
R123	1-216-845-11	METAL CHIP 100K 5%	1/16W
R125	1-216-839-11	METAL CHIP 33K 5%	1/16W
R201	1-216-833-11	METAL CHIP 10K 5%	1/16W
R202	1-216-864-11	METAL CHIP 0 5%	1/16W
R204	1-216-853-11	METAL CHIP 470K 5%	1/16W
R207	1-216-821-11	METAL CHIP 1K 5%	1/16W
R210	1-216-821-11	METAL CHIP 1K 5%	1/16W
R211	1-216-845-11	METAL CHIP 100K 5%	1/16W
R221	1-216-833-11	METAL CHIP 10K 5%	1/16W
R222	1-216-833-11	METAL CHIP 10K 5%	1/16W
R223	1-216-821-11	METAL CHIP 1K 5%	1/16W
R301	1-216-841-11	METAL CHIP 47K 5%	1/16W
R302	1-216-845-11	METAL CHIP 100K 5%	1/16W
R303	1-216-846-11	METAL CHIP 120K 5%	1/16W
R304	1-216-847-11	METAL CHIP 150K 5%	1/16W
R305	1-216-845-11	METAL CHIP 100K 5%	1/16W

Ref. No.	Part No.	Description	Remark
R306	1-216-841-11	METAL CHIP 47K 5%	1/16W
R309	1-216-841-11	METAL CHIP 47K 5%	1/16W
R310	1-216-845-11	METAL CHIP 100K 5%	1/16W
R311	1-216-845-11	METAL CHIP 100K 5%	1/16W
R403	1-218-867-11	RES-CHIP 6.8K 2%	1/16W
R404	1-218-867-11	RES-CHIP 6.8K 2%	1/16W
R405	1-218-867-11	RES-CHIP 6.8K 2%	1/16W
R406	1-218-867-11	RES-CHIP 6.8K 2%	1/16W
R407	1-216-830-11	METAL CHIP 5.6K 5%	1/16W
R408	1-216-839-11	METAL CHIP 33K 5%	1/16W
R409	1-219-316-11	RES-CHIP 12K 2%	1/16W
R410	1-219-316-11	RES-CHIP 12K 2%	1/16W
R411	1-219-316-11	RES-CHIP 12K 2%	1/16W
R412	1-219-316-11	RES-CHIP 12K 2%	1/16W
R413	1-219-274-11	RES-CHIP 220 2%	1/16W
R414	1-219-274-11	RES-CHIP 220 2%	1/16W
R415	1-216-845-11	METAL CHIP 100K 5%	1/16W
R416	1-216-845-11	METAL CHIP 100K 5%	1/16W
R417	1-216-830-11	METAL CHIP 5.6K 5%	1/16W
R418	1-216-839-11	METAL CHIP 33K 5%	1/16W
R420	1-216-864-11	METAL CHIP 0 5%	1/16W
R421	1-219-282-21	RES-CHIP 470 2%	1/16W
R422	1-219-282-21	RES-CHIP 470 2%	1/16W
R501	1-218-871-11	RES-CHIP 10K 2%	1/16W
R502	1-218-871-11	RES-CHIP 10K 2%	1/16W
R503	1-218-871-11	RES-CHIP 10K 2%	1/16W
R504	1-218-871-11	RES-CHIP 10K 2%	1/16W
R505	1-218-871-11	RES-CHIP 10K 2%	1/16W
R506	1-218-871-11	RES-CHIP 10K 2%	1/16W
< VARIABLE RESISTOR >			
RV201	1-223-834-11	RES, ADJ, CARBON 47K	
< SWITCH >			
SW201	1-529-565-41	SWITCH, PUSH (1KEY) (MAGAZINE DETECT)	
< VIBRATOR >			
X201	1-781-282-11	VIBRATOR, CERAMIC (4MHz)	
X501	1-760-307-11	VIBRATOR, CERAMIC (16.9344MHz)	
*****			
*	1-679-422-12	LSW BOARD	
*****			
< SWITCH >			
SW3	1-529-565-41	SWITCH, PUSH (1KEY) (LIMIT)	
*****			
*	A-3326-947-A	RF BOARD, COMPLETE	
*****			
< CAPACITOR >			
C101	1-107-826-11	CERAMIC CHIP 0.1uF 10%	16V
C102	1-126-206-11	ELECT CHIP 100uF 20%	6.3V
C103	1-164-156-11	CERAMIC CHIP 0.1uF	25V
C104	1-107-826-11	CERAMIC CHIP 0.1uF 10%	16V
C105	1-126-206-11	ELECT CHIP 100uF 20%	6.3V





# CDX-602

Ref. No.	Part No.	Description	Remark
ACCESSORIES & PACKING MATERIALS			
*****			

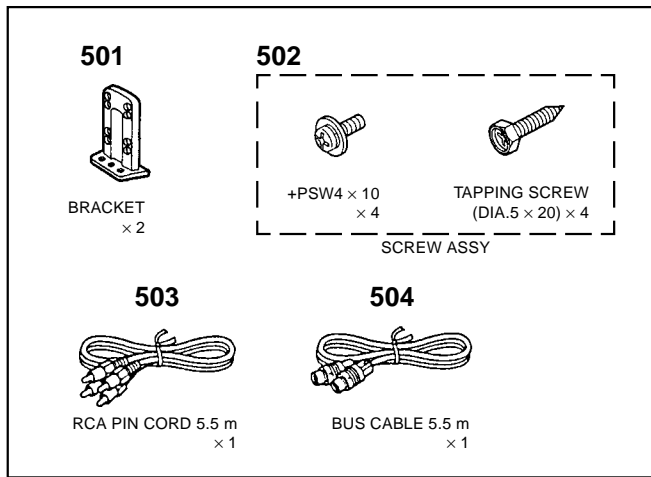
3-225-284-11	MANUAL, INSRTUCTION (ENGLISH, FRENCH, SPANISH, TRADITIONAL CHINESE)		
A-3301-944-A	MAGAZINE (250T) ASSY		

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PARTS FOR INSTALLATION AND CONNECTIONS

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501	3-040-583-21	BRACKET (T)	
* 502	X-3369-824-1	SCREW ASSY	
503	1-590-874-11	CORD, CONNECTION (RCA PIN CORD 5.5m)	
504	1-590-519-21	CORD (WITH CONNECTOR) (BUS CABLE 5.5m)	



MEMO

